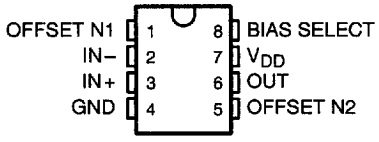
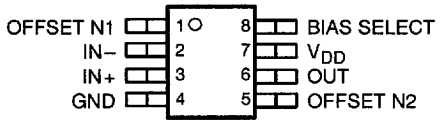
- **Wide Range of Supply Voltages Over Specified Temperature Range: T_A = –40°C to 85°C . . . 2 V to 8 V**
- **Fully Characterized at 3 V and 5 V**
- **Single-Supply Operation**
- **Common-Mode Input-Voltage Range Extends Below the Negative Rail and up to V_{DD} –1 V at 25°C**
- **Output Voltage Range Includes Negative Rail**
- **High Input Impedance . . . 10^{12} Ω Typ**
- **Low Noise . . . 25 nV/√Hz Typically at f = 1 kHz (High-Bias Mode)**
- **ESD-Protection Circuitry**
- **Designed-In Latch-Up Immunity**
- **Bias-Select Feature Enables Maximum Supply Current Range From 17 μA to 1.5 mA at 25°C**

D OR P PACKAGE
(TOP VIEW)



PW PACKAGE
(TOP VIEW)



description

The TLV2341 operational amplifier has been specifically developed for low-voltage, single-supply applications and is fully specified to operate over a voltage range of 2 V to 8 V. The device uses the Texas Instruments silicon-gate LinCMOS™ technology to facilitate low-power, low-voltage operation and excellent offset-voltage stability. LinCMOS™ technology also enables extremely high input impedance and low bias currents allowing direct interface to high-impedance sources.

The TLV2341 offers a bias-select feature, which allows the device to be programmed with a wide range of different supply currents and therefore different levels of ac performance. The supply current can be set at 17 μA, 250 μA, or 1.5 mA, which results in slew-rate specifications between 0.02 and 2.1 V/μs (at 3 V).

The TLV2341 operational amplifiers are especially well suited to single-supply applications and are fully specified and characterized at 3-V and 5-V power supplies. This low-voltage single-supply operation combined with low power consumption makes this device a good choice for remote, inaccessible, or portable battery-powered applications. The common-mode input range includes the negative rail.

The device inputs and outputs are designed to withstand –100-mA currents without sustaining latch-up. The TLV2341 incorporates internal ESD-protection circuits that prevents functional failures at voltages up to 2000 V as tested under MIL-STD 883 C, Methods 3015.2; however, care should be exercised in handling these devices as exposure to ESD may result in the degradation of the device parametric performance.

AVAILABLE OPTIONS

T_A	V_{IO}max AT 25°C	PACKAGED DEVICES			CHIP FORM (Y)
		SMALL OUTLINE (D)	PLASTIC DIP (P)	TSSOP (PW)	
–40°C to 85°C	8 mV	TLV2341ID	TLV2341IP	TLV2341IPWLE	TLV2341Y

The D package is available taped and reeled. Add R suffix to the device type (e.g., TLV2341IDR).
The PW package is only available left-end taped and reeled (e.g., TLV2341IPWLE).

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bias-select feature

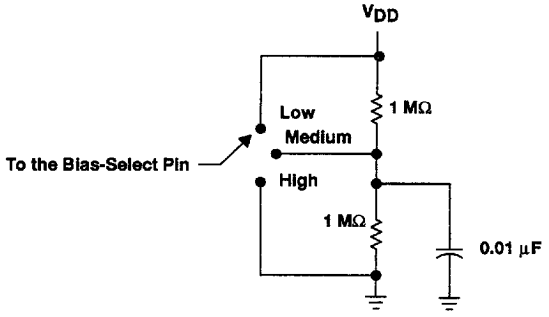
The TLV2342 offers a bias-select feature that allows the user to select any one of three bias levels, depending on the level of performance desired. The tradeoffs between bias levels involve ac performance and power dissipation (see Table 1).

Table 1. Effect of Bias Selection on Performance

TYPICAL PARAMETER VALUES T_A = 25°C, V_{DD} = 3 V		MODE			UNIT
		HIGH BIAS R_L = 10 kΩ	MEDIUM BIAS R_L = 100 kΩ	LOW BIAS R_L = 1 MΩ	
P_D	Power dissipation	975	195	15	μW
SR	Slew rate	2.1	0.38	0.02	V/μs
V_n	Equivalent input noise voltage at f = 1 kHz	25	32	68	nV/√Hz
B_1	Unity-gain bandwidth	790	300	27	kHz
ϕ_m	Phase margin	46°	39°	34°	
A_{VD}	Large-signal differential voltage amplification	11	83	400	V/mV

bias selection

Bias selection is achieved by connecting BIAS SELECT to one of three voltage levels (see Figure 1). For medium-bias applications, it is recommended that the bias-select pin be connected to the midpoint between the supply rails. This procedure is simple in split-supply applications since this point is ground. In single-supply applications, the medium-bias mode necessitates using a voltage divider as indicated in Figure 1. The use of large-value resistors in the voltage divider reduces the current drain of the divider from the supply line. However, large-value resistors used in conjunction with a large-value capacitor require significant time to charge up to the supply midpoint after the supply is switched on. A voltage other than the midpoint may be used if it is within the voltages specified in the following table.



BIAS MODE	BIAS-SELECT VOLTAGE (single supply)
Low	V_{DD}
Medium	1 V to V_{DD} – 1 V
High	GND

Figure 1. Bias Selection for Single-Supply Applications

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high-bias mode

In the high-bias mode, the TLV2341 series feature low offset voltage drift, high input impedance, and low noise. Speed in this mode approaches that of BiFET devices but at only a fraction of the power dissipation.

medium-bias mode

The TLV2341 in the medium-bias mode features a low offset voltage drift, high input impedance, and low noise. Speed in this mode is similar to general-purpose bipolar devices but power dissipation is only a fraction of that consumed by bipolar devices.

low-bias mode

In the low-bias mode, the TLV2341 features low offset voltage drift, high input impedance, extremely low power consumption, and high differential voltage gain.

ORDER OF CONTENTS

TOPIC	BIAS MODE
Schematic	all
Absolute maximum ratings	all
Recommended operating conditions	all
Electrical characteristics Operating characteristics Typical characteristics	high (Figures 2 – 31)
Electrical characteristics Operating characteristics Typical characteristics	medium (Figures 32 – 61)
Electrical characteristics Operating characteristics Typical characteristics	low (Figures 62 – 91)
Parameter measurement information	all
Application information	all

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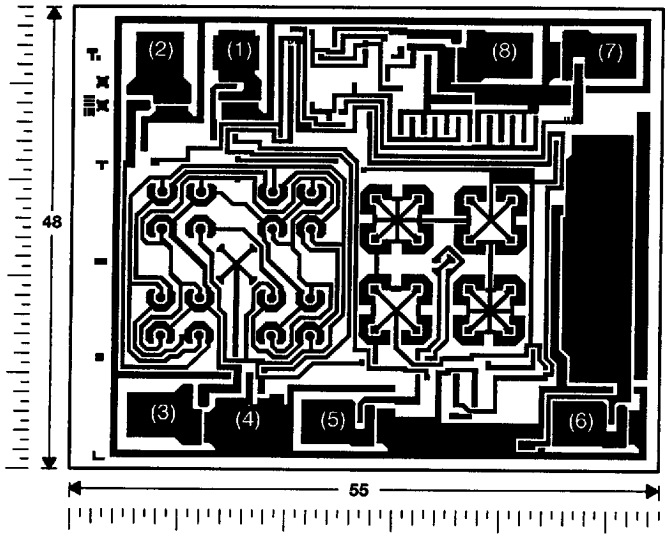
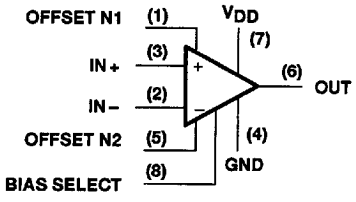
TLV2341Y chip information

This chip, when properly assembled, displays characteristics similar to the TLV2341. Thermal compression or ultrasonic bonding may be used on the doped-aluminum bonding pads. Chips may be mounted with conductive epoxy or a gold-silicon preform.

BONDING PAD ASSIGNMENTS





CHIP THICKNESS: 15 TYPICAL

BONDING PADS: 4 × 4 MINIMUM

$T_J$max = 150°C

TOLERANCES ARE ±10%.

ALL DIMENSIONS ARE IN MILS.

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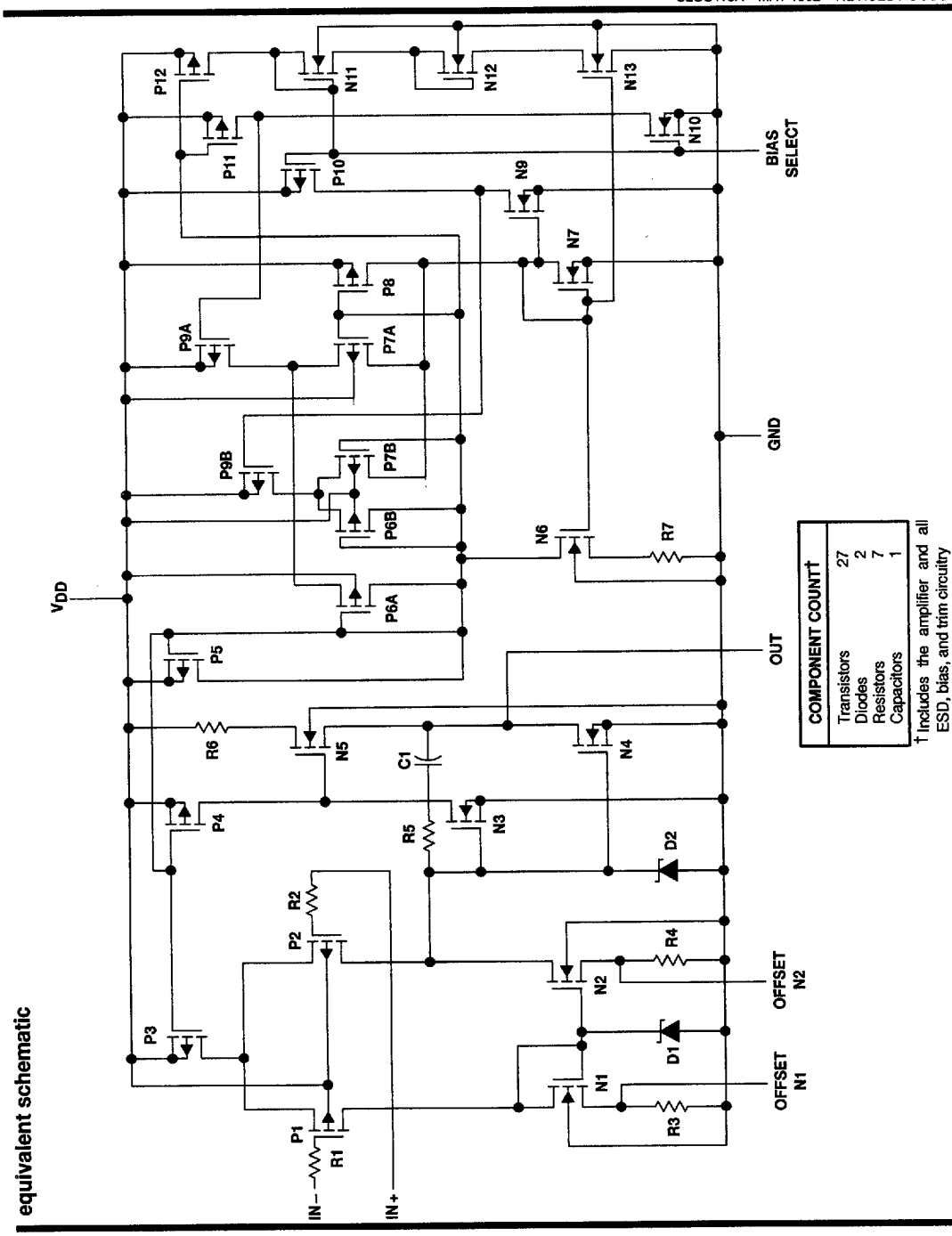
equivalent schematic



COMPONENT COUNT†	
Transistors	27
Diodes	2
Resistors	7
Capacitors	1

† Includes the amplifier and all ESD, bias, and trim circuitry

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{DD} (see Note 1) ..... 8 V
Differential input voltage (see Note 2) ..... $V_{DD\pm}$
Input voltage range, V_I (any input) ..... −0.3 V to V_{DD}
Input current, I_I ..... ±5 mA
Output current, I_O ..... ±30 mA
Duration of short-circuit current at (or below) T_A = 25°C (see Note 3) ..... unlimited
Continuous total dissipation ..... See Dissipation Rating Table
Operating free-air temperature range, T_A ..... −40°C to 85°C
Storage temperature range ..... −65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds ..... 260°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may effect device reliability.

NOTES: 1. All voltage values, except differential voltages, are with respect to network ground.
2. Differential voltages are at the noninverting input with respect to the inverting input.
3. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded (see application section).

DISSIPATION RATING TABLE

PACKAGE	$T_A \le 25°C$ POWER RATING	DERATING FACTOR ABOVE T_A = 25°C	T_A = 85°C POWER RATING
D	725 mW	5.8 mW/°C	377 mW
P	1000 mW	8.0 mW/°C	520 mW
PW	525 mW	4.2 mW/°C	273 mW

recommended operating conditions

		MIN	MAX	UNIT
Supply voltage, V_{DD}		2	8	V
Common-mode input voltage, V_{IC}	V_{DD} = 3 V	−0.2	1.8	V
	V_{DD} = 5 V	−0.2	3.8	
Operating free-air temperature, T_A		−40	85	°C

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HIGH-BIAS MODE

electrical characteristics at specified free-air temperature

PARAMETER		TEST CONDITIONS	T_A†	TLV2341I						UNIT
				V_{DD} = 3 V			V_{DD} = 5 V			
				MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	Input offset voltage	V_O = 1 V, V_{IC} = 1 V, R_S = 50 Ω, R_L = 10 kΩ	25°C		0.6	8		1.1	8	mV
			Full range			10			10	
α_{VIO}	Average temperature of input offset voltage		25°C to 85°C		2.7			2.7		μV/°C
I_{IO}	Input offset current (see Note 4)	V_O = 1 V, V_{IC} = 1 V	25°C		0.1			0.1		pA
			85°C		22	1000		24	1000	
I_{IB}	Input bias current (see Note 4)	V_O = 1 V, V_{IC} = 1 V	25°C		0.6			0.6		pA
			85°C		175	2000		200	2000	
V_{ICR}	Common-mode input voltage range (see Note 5)		25°C	−0.2 to 2	−0.3 to 2.3		−0.2 to 4	−0.3 to 4.2		V
			Full range	−0.2 to 1.8			−0.2 to 3.8			V
V_{OH}	High-level output voltage	V_{IC} = 1 V, V_{ID} = 100 mV, I_{OH} = −1 mA	25°C	1.75	1.9		3.2	3.7		V
			Full range	1.7			3			
V_{OL}	Low-level output voltage	V_{IC} = 1 V, V_{ID} = −100 mV, I_{OL} = 1 mA	25°C		120	150		90	150	mV
			Full range			190			190	
A_{VD}	Large-signal differential voltage amplification	V_{IC} = 1 V, R_L = 10 kΩ, See Note 6	25°C	3	11		5	23		V/mV
			Full range	2			3.5			
CMRR	Common-mode rejection ratio	V_O = 1 V, V_{IC} = V_{ICR}min, R_S = 50 Ω	25°C	65	78		65	80		dB
			Full range	60			60			
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{DD}/\Delta V_{IO}$)	V_{IC} = 1 V, V_O = 1 V, R_S = 50 Ω	25°C	70	95		70	95		dB
			Full range	65			65			
$I_{I(SEL)}$	Bias select current	$V_{I(SEL)}$ = 0	25°C		−1.2			−1.4		μA
I_{DD}	Supply current	V_O = 1 V, V_{IC} = 1 V, No load	25°C		325	1500		675	1600	μA
			Full range			2000			2200	

† Full range is −40°C to 85°C.

NOTES: 4. The typical values of input bias current and input offset current below 5 pA are determined mathematically.
5. This range also applies to each input individually.
6. At V_{DD} = 5 V, V_O = 0.25 V to 2 V; at V_{DD} = 3 V, V_O = 0.5 V to 1.5 V.

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HIGH-BIAS MODE

operating characteristics at specified free-air temperature, V_{DD} = 3 V

PARAMETER		TEST CONDITIONS		T_A	TLV2341I			UNIT
					MIN	TYP	MAX	
SR	Slew rate at unity gain	V_{IC} = 1 V, R_L = 10 kΩ, See Figure 92	$V_{I(PP)}$ = 1 V, C_L = 20 pF,	25°C		2.1		V/μs
				85°C		1.7		
V_n	Equivalent input noise voltage	f = kHz, See Figure 93	R_S = 20 Ω,	25°C		25		nV/√Hz
B_{OM}	Maximum output-swing bandwidth	V_O = V_{OH}, R_L = 10 kΩ,	C_L = 20 pF, See Figure 92	25°C		170		kHz
				85°C		145		
B_1	Unity-gain bandwidth	V_I = 10 mV, R_L = 10 kΩ,	C_L = 20 pF, See Figure 94	25°C		790		kHz
				85°C		690		
ϕ_m	Phase margin	V_I = 10 mV, C_L = 20 pF, See Figure 94	f = B_1, R_L = 1 MΩ,	−40°C		53°		
				25°C		49°		
				85°C		47°		

operating characteristics at specified free-air temperature, V_{DD} = 5 V

PARAMETER		TEST CONDITIONS		T_A	TLV2341I			UNIT
					MIN	TYP	MAX	
SR	Slew rate at unity gain	V_{IC} = 1 V, R_L = 10 kΩ, C_L = 20 pF, See Figure 92	$V_{I(PP)}$ = 1 V	25°C		3.6		V/μs
				85°C		2.8		
			$V_{I(PP)}$ = 2.5 V	25°C		2.9		
				85°C		2.3		
V_n	Equivalent input noise voltage	f = 1 kHz, See Figure 93	R_S = 20 Ω,	25°C		25		nV/√Hz
B_{OM}	Maximum output-swing bandwidth	V_O = V_{OH}, R_L = 10 kΩ,	C_L = 20 pF, See Figure 92	25°C		320		kHz
				85°C		250		
B_1	Unity-gain bandwidth	V_I = 10 mV, R_L = 10 kΩ,	C_L = 20 pF, See Figure 94	25°C		1.7		MHz
				85°C		1.2		
ϕ_m	Phase margin	V_I = 10 mV, C_L = 20 pF, See Figure 94	f = B_1, R_L = 10 kΩ,	−40°C		49°		
				25°C		46°		
				85°C		43°		

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HIGH-BIAS MODE

electrical characteristics, T_A = 25°C

PARAMETER		TEST CONDITIONS		TLV2341I						UNIT
				V_{DD} = 3 V			V_{DD} = 5 V			
				MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	Input offset voltage	V_O = 1 V, R_S = 50 Ω,	V_{IC} = 1 V, R_L = 10 kΩ		0.6	8		1.1	8	mV
I_{IO}	Input offset current (see Note 4)	V_O = 1 V,	V_{IC} = 1 V		0.1			0.1		pA
I_{IB}	Input bias current (see Note 4)	V_O = 1 V,	V_{IC} = 1 V		0.6			0.6		pA
V_{ICR}	Common-mode input voltage range (see Note 5)			−0.2 to 2	−0.3 to 2.3		−0.2 to 4	−0.3 to 4.2		V
V_{OH}	High-level output voltage	V_{IC} = 1 V, I_{OH} = −1 mA	V_{ID} = 100 mV,	1.75	1.9		3.2	3.7		V
V_{OL}	Low-level output voltage	V_{IC} = 1 V, I_{OL} = 1 mA	V_{ID} = −100 mV,		120	150		90	150	mV
A_{VD}	Large-signal differential voltage amplification	V_{IC} = 1 V, See Note 6	R_L = 10 kΩ,	3	11		50	23		V/mV
CMRR	Common-mode rejection ratio	V_O = 1 V, R_S = 50 Ω	V_{IC} = V_{ICR}min,	65	78		65	80		dB
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{DD}/\Delta V_{IO}$)	V_O = 1 V, R_S = 50 Ω	V_{IC} = 1 V,	70	95		70	95		dB
$I_{I(SEL)}$	Bias select current	$V_{I(SEL)}$ = 0			−1.2			−1.4		µA
I_{DD}	Supply current	V_O = 1 V, No load	V_{IC} = 1 V,		325	1500		675	1600	µA

NOTES: 4. The typical values of input bias current and input offset current below 5 pA are determined mathematically.
5. This range also applies to each input individually.
6. At V_{DD} = 5 V, V_O = 0.25 V to 2 V; at V_{DD} = 3 V, V_O = 0.5 V to 1.5 V.

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TYPICAL CHARACTERISTICS (HIGH-BIAS MODE)

Table of Graphs

			FIGURE
V_{IO}	Input offset voltage	Distribution	2,3
α_{VIO}	Input offset voltage temperature coefficient	Distribution	4,5
V_{OH}	High-level output voltage	vs Output current vs Supply voltage vs Temperature	6 7 8
V_{OL}	Low-level output voltage	vs Common-mode input voltage vs Temperature vs Differential input voltage vs Low-level output current	9 10, 12 11 13
A_{VD}	Large-signal differential voltage amplification	vs Supply voltage vs Temperature vs Frequency	14 15 26, 27
I_{IB}	Input bias current	vs Temperature	16
I_{IO}	Input offset current	vs Temperature	16
V_{IC}	Common-mode input voltage	vs Supply voltage	17
I_{DD}	Supply current	vs Supply voltage vs Temperature	18 19
SR	Slew rate	vs Supply voltage vs Temperature	20 21
	Bias select current	vs Supply voltage	22
$V_{O(PP)}$	Maximum peak-to-peak output voltage	vs Frequency	23
B_1	Unity-gain bandwidth	vs Temperature vs Supply voltage	24 25
ϕ_m	Phase margin	vs Supply voltage vs Temperature vs Load capacitance	28 29 30
V_n	Equivalent input noise voltage	vs Frequency	31
	Phase shift	vs Frequency	26, 27

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TYPICAL CHARACTERISTICS (HIGH-BIAS MODE)

DISTRIBUTION OF TLV2341
INPUT OFFSET VOLTAGE

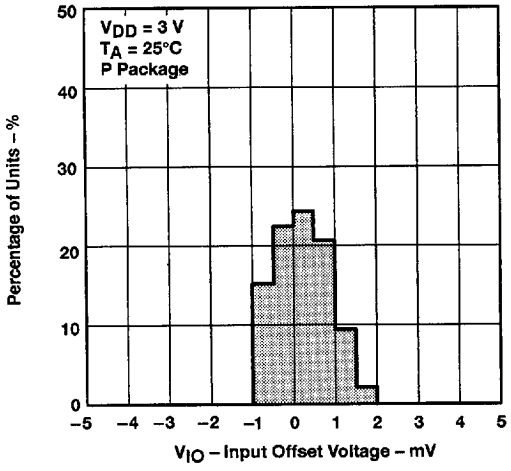

Figure 2

DISTRIBUTION OF TLV2341
INPUT OFFSET VOLTAGE

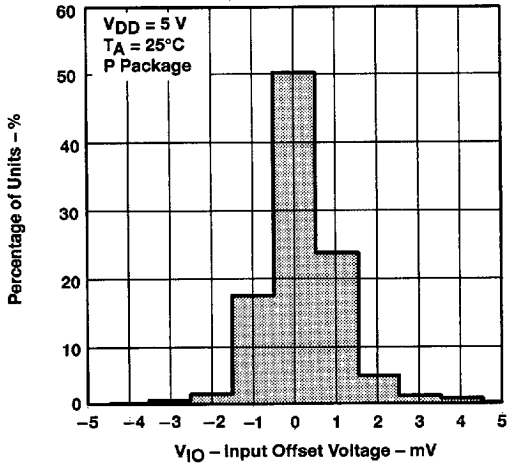

Figure 3

DISTRIBUTION OF TLV2341
INPUT OFFSET VOLTAGE
TEMPERATURE COEFFICIENT

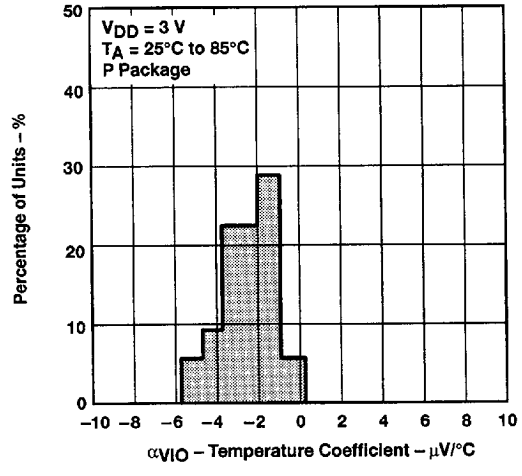

Figure 4

DISTRIBUTION OF TLV2341
INPUT OFFSET VOLTAGE
TEMPERATURE COEFFICIENT

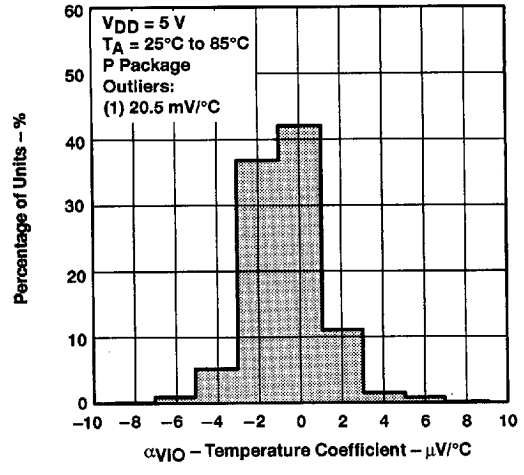

Figure 5

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TYPICAL CHARACTERISTICS (HIGH-BIAS MODE)

HIGH-LEVEL OUTPUT VOLTAGE
vs
HIGH-LEVEL OUTPUT CURRENT

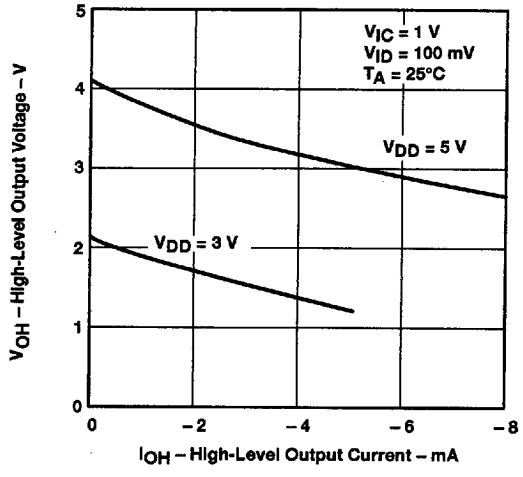

Figure 6

HIGH-LEVEL OUTPUT VOLTAGE
vs
SUPPLY VOLTAGE

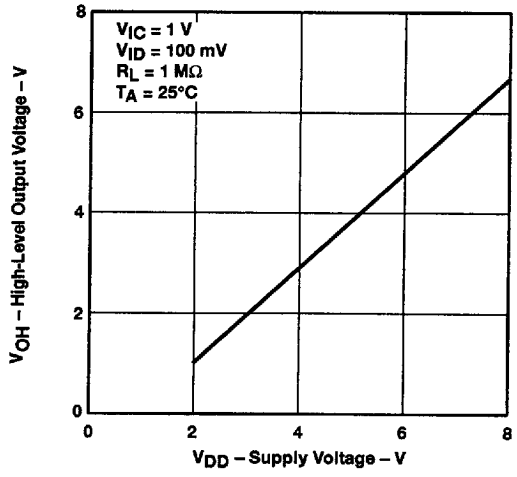

Figure 7

HIGH-LEVEL OUTPUT VOLTAGE
vs
FREE-AIR TEMPERATURE

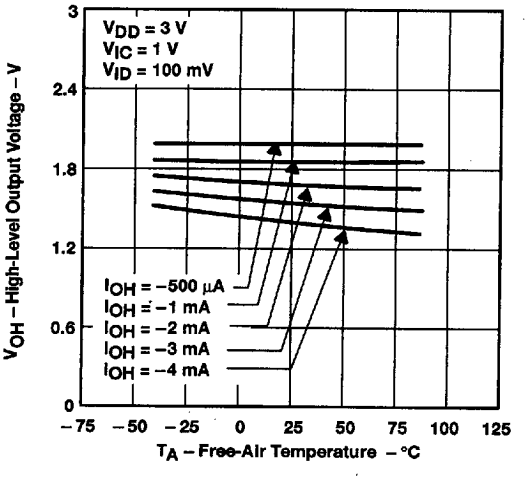

Figure 8

LOW-LEVEL OUTPUT VOLTAGE
vs
COMMON-MODE INPUT VOLTAGE

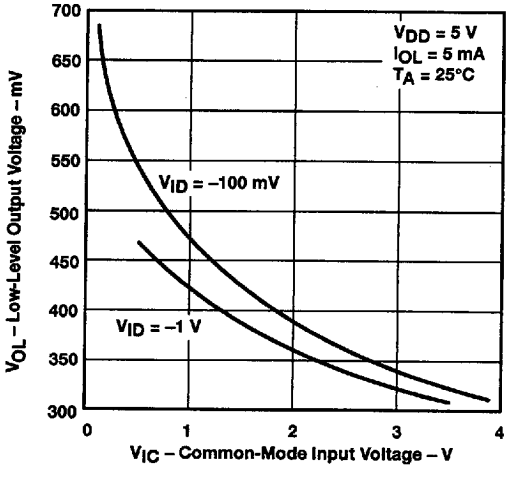

Figure 9

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TYPICAL CHARACTERISTICS (HIGH-BIAS MODE)

LOW-LEVEL OUTPUT VOLTAGE
vs
FREE-AIR TEMPERATURE

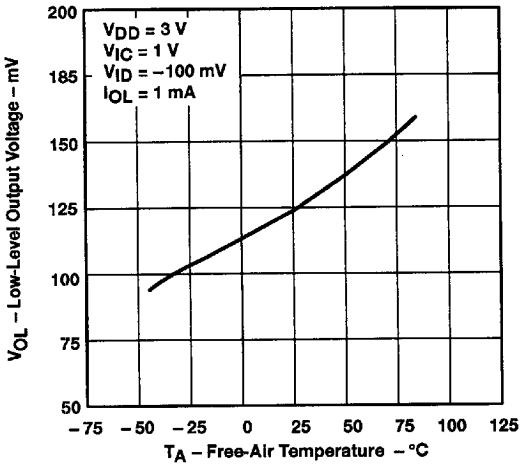

Figure 10

LOW-LEVEL OUTPUT VOLTAGE
vs
DIFFERENTIAL INPUT VOLTAGE

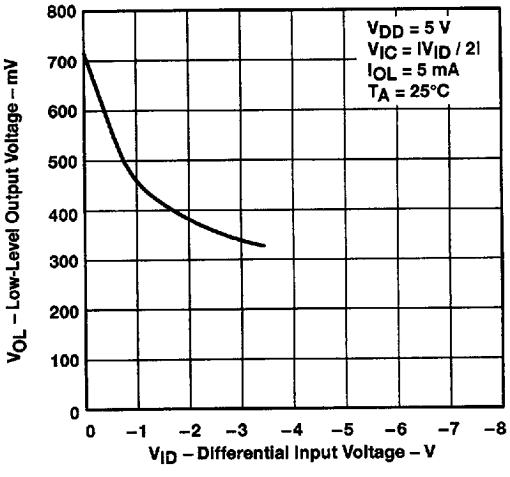

Figure 11

LOW-LEVEL OUTPUT VOLTAGE
vs
FREE-AIR TEMPERATURE

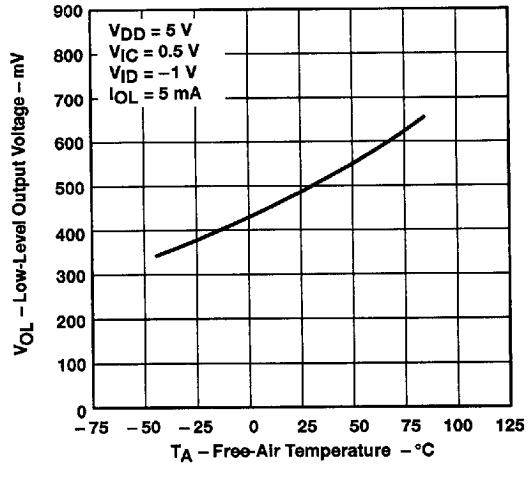

Figure 12

LOW-LEVEL OUTPUT VOLTAGE
vs
LOW-LEVEL OUTPUT CURRENT

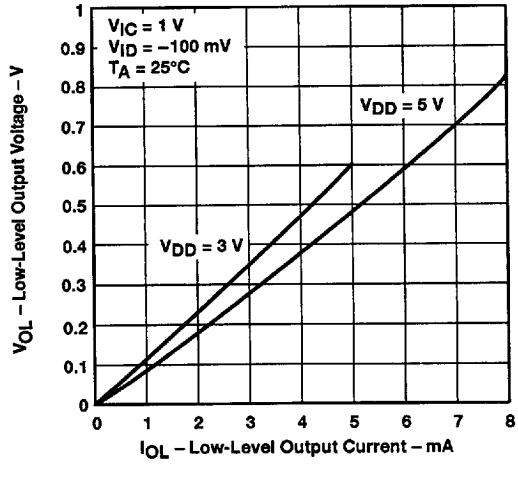

Figure 13

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TYPICAL CHARACTERISTICS (HIGH-BIAS MODE)

LARGE-SIGNAL
DIFFERENTIAL VOLTAGE AMPLIFICATION
vs
SUPPLY VOLTAGE

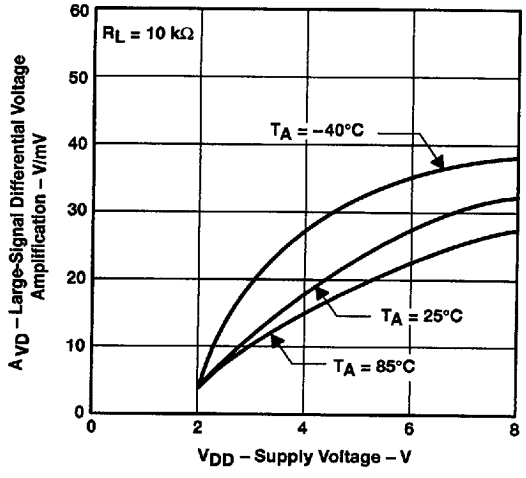


Figure 14

LARGE-SIGNAL
DIFFERENTIAL VOLTAGE AMPLIFICATION
vs
FREE-AIR TEMPERATURE

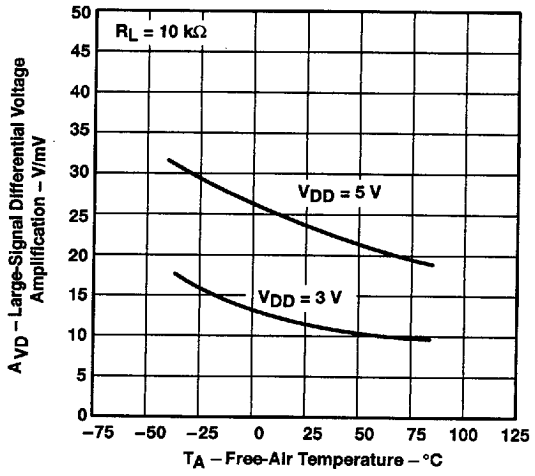
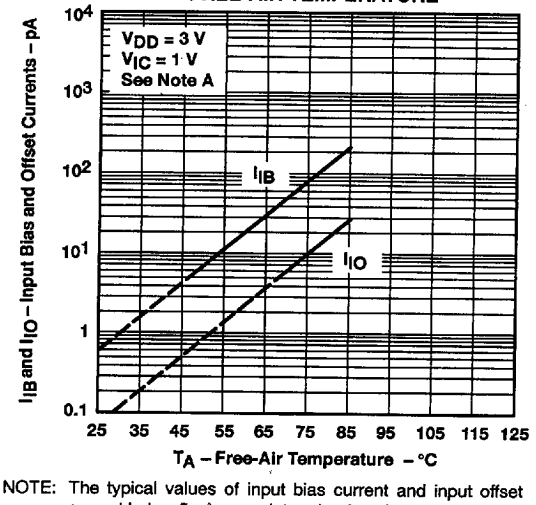


Figure 15

INPUT BIAS CURRENT AND INPUT OFFSET
CURRENT
vs
FREE-AIR TEMPERATURE



NOTE: The typical values of input bias current and input offset current below 5 pA were determined mathematically.

Figure 16

COMMON-MODE INPUT VOLTAGE
POSITIVE LIMIT
vs
SUPPLY VOLTAGE

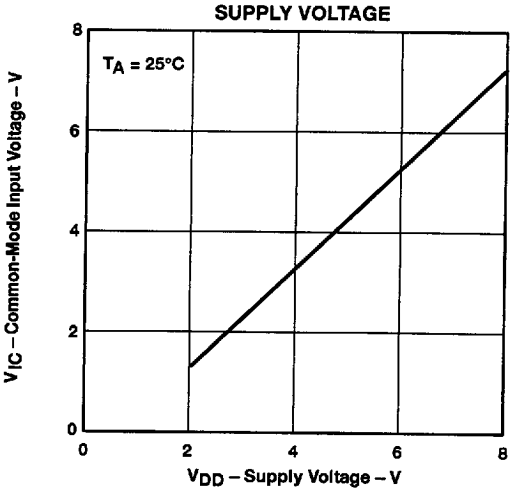


Figure 17

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TYPICAL CHARACTERISTICS (HIGH-BIAS MODE)

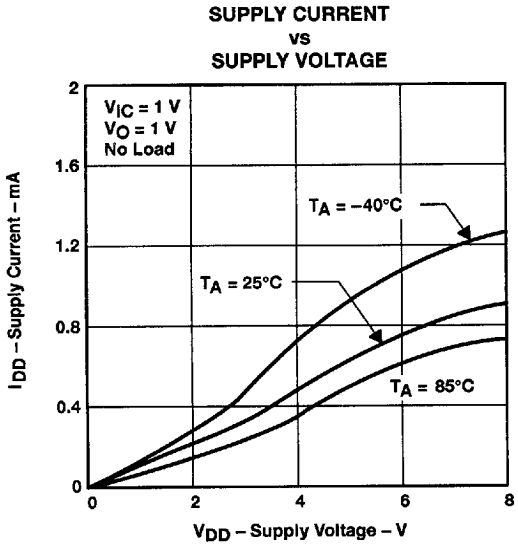

Figure 18

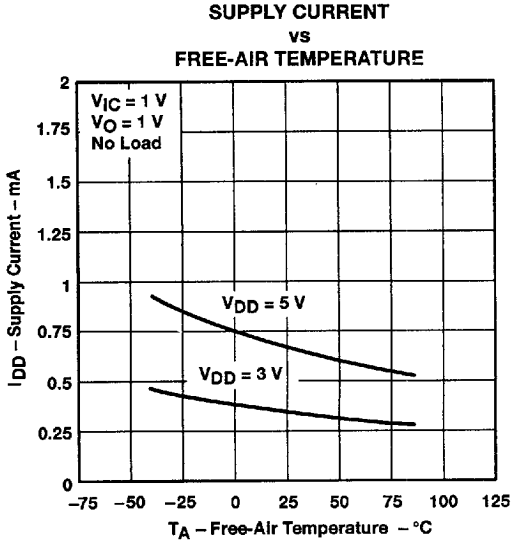

Figure 19

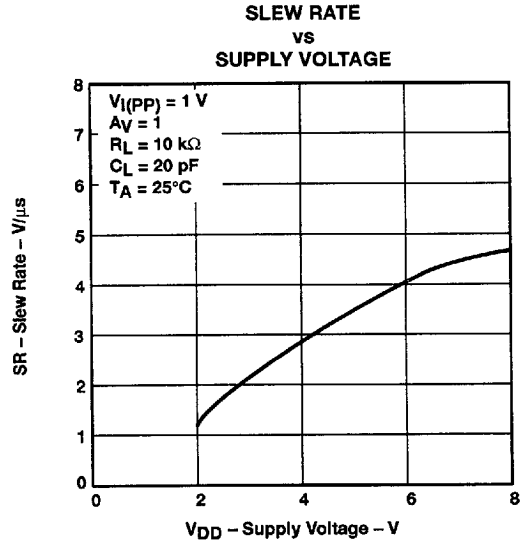

Figure 20

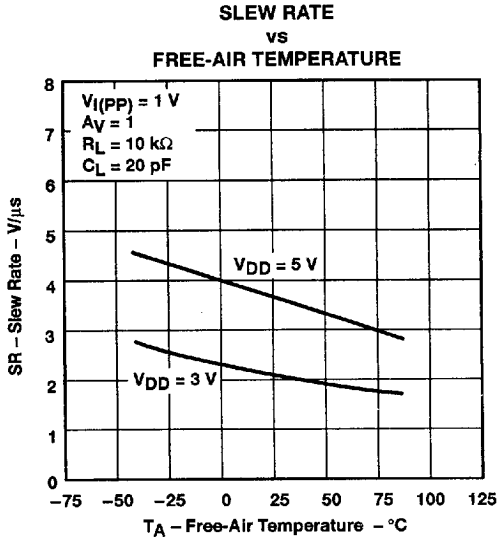

Figure 21

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TYPICAL CHARACTERISTICS (HIGH-BIAS MODE)

BIAS SELECT CURRENT
vs
SUPPLY VOLTAGE

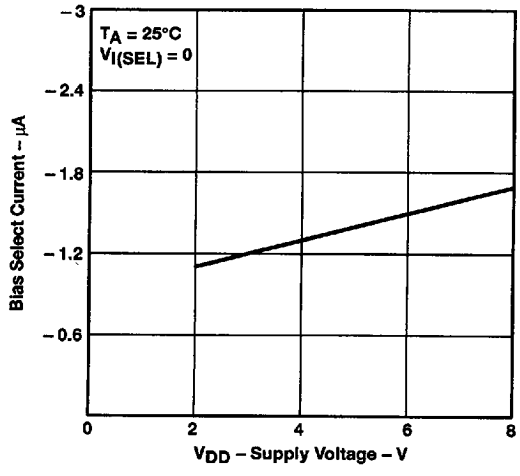

Figure 22

MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE
vs
FREQUENCY

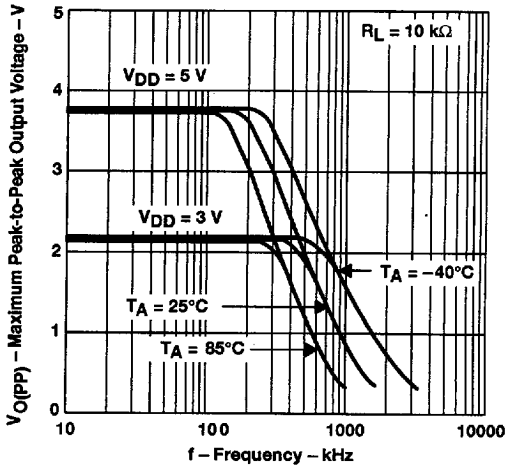

Figure 23

UNITY-GAIN BANDWIDTH
vs
FREE-AIR TEMPERATURE

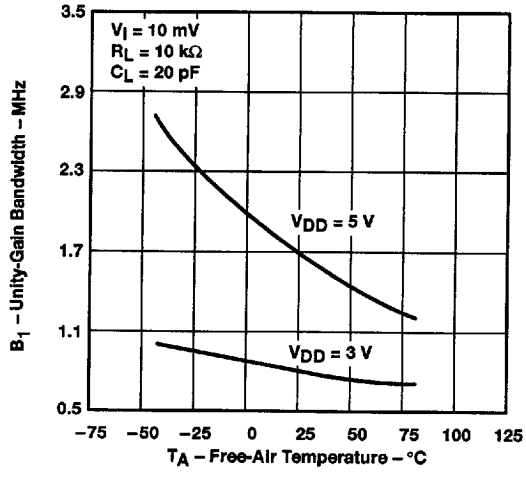

Figure 24

UNITY-GAIN BANDWIDTH
vs
SUPPLY VOLTAGE

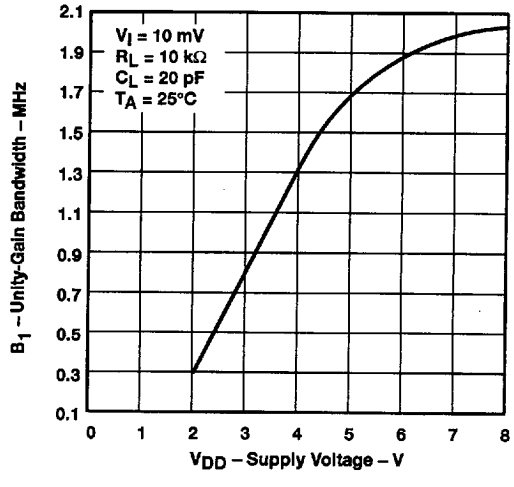

Figure 25

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TYPICAL CHARACTERISTICS (HIGH-BIAS MODE)

LARGE-SIGNAL DIFFERENTIAL VOLTAGE
AMPLIFICATION AND PHASE SHIFT
vs
FREQUENCY

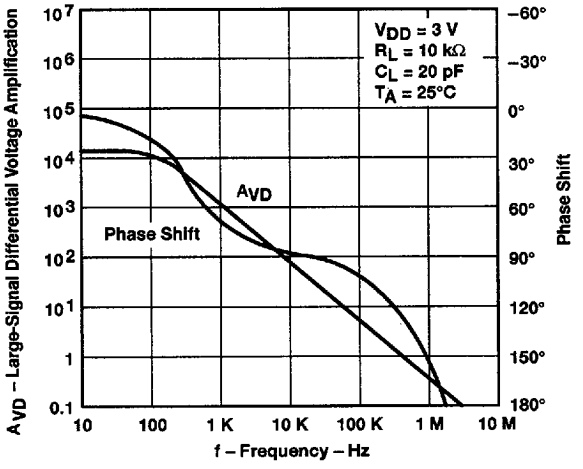

Figure 26

LARGE-SIGNAL DIFFERENTIAL VOLTAGE
AMPLIFICATION AND PHASE SHIFT
vs
FREQUENCY

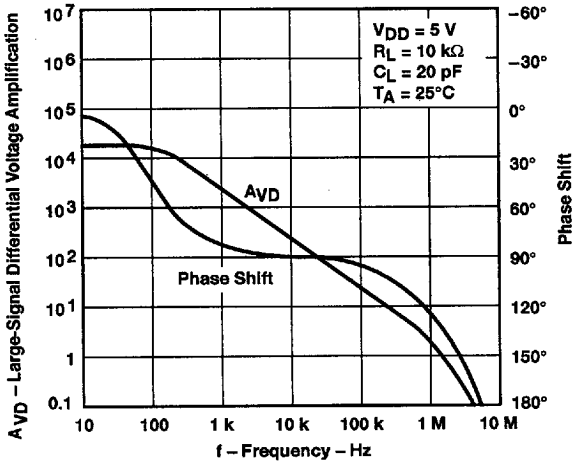

Figure 27

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TYPICAL CHARACTERISTICS (HIGH-BIAS MODE)

PHASE MARGIN vs SUPPLY VOLTAGE

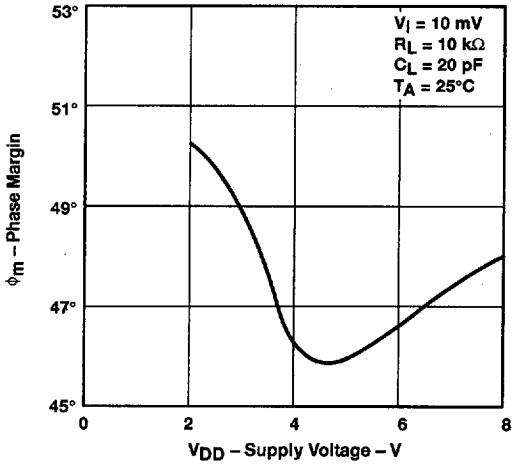

Figure 28

PHASE MARGIN vs FREE-AIR TEMPERATURE

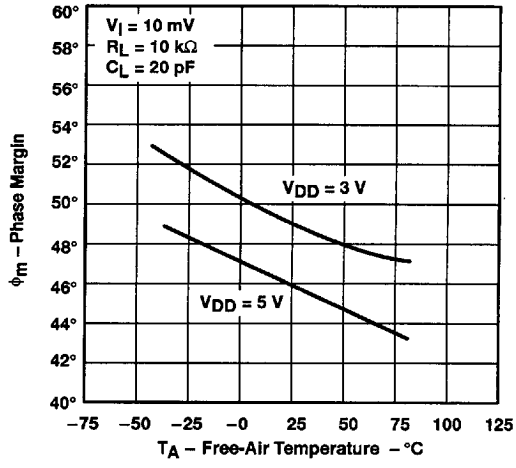

Figure 29

PHASE MARGIN vs LOAD CAPACITANCE

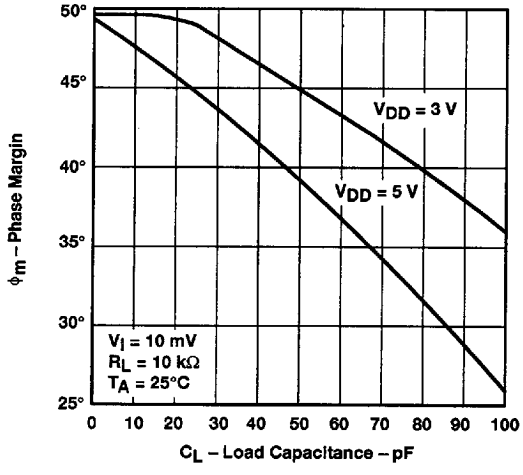

Figure 30

EQUIVALENT INPUT NOISE VOLTAGE vs FREQUENCY

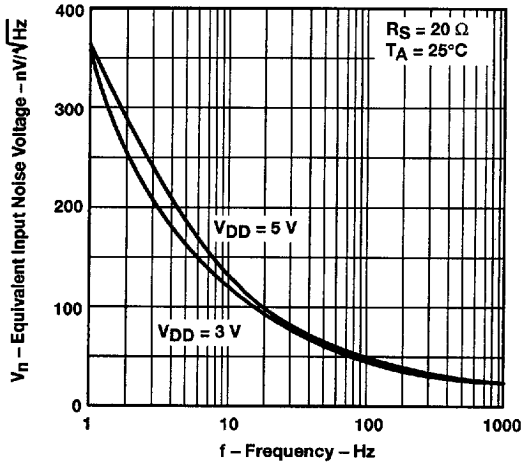

Figure 31

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MEDIUM-BIAS MODE

electrical characteristics at specified free-air temperature

PARAMETER		TEST CONDITIONS	T_A†	TLV2341I						UNIT
				V_{DD} = 3 V			V_{DD} = 5 V			
				MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	Input offset voltage	V_O = 1 V, V_{IC} = 1 V, R_S = 50 Ω, R_L = 100 kΩ	25°C		0.6	8		1.1	8	mV
			Full range			10			10	
α_{VIO}	Average temperature coefficient of input offset voltage		25°C to 85°C		1			1.7		µV/°C
I_{IO}	Input offset current (see Note 4)	V_O = 1 V, V_{IC} = 1 V	25°C		0.1			0.1		pA
			85°C		22	1000		24	1000	
I_{IB}	Input bias current (see Note 4)	V_O = 1 V, V_{IC} = 1 V	25°C		0.6			0.6		pA
			85°C		175	2000		200	2000	
V_{ICR}	Common-mode input voltage range (see Note 5)		25°C	−0.2 to 2	−0.3 to 2.3		−0.2 to 4	−0.3 to 4.2		V
			Full range	−0.2 to 1.8			−0.2 to 3.8			V
V_{OH}	High-level output voltage	V_{IC} = 1 V, V_{ID} = 100 mV, I_{OH} = −1 mA	25°C	1.75	1.9		3.2	3.9		V
			Full range	1.7			3			
V_{OL}	Low-level output voltage	V_{IC} = 1 V, V_{ID} = −100 mV, I_{OL} = 1 mA	25°C		115	150		95	150	mV
			Full range			190			190	
A_{VD}	Large-signal differential voltage amplification	V_{IC} = 1 V, R_L = 100 kΩ, See Note 6	25°C	25	83		25	170		V/mV
			Full range	15			15			
CMRR	Common-mode rejection ratio	V_O = 1 V, V_{IC} = V_{ICR}min, R_S = 50 Ω	25°C	65	92		65	91		dB
			Full range	60			60			
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{DD}/\Delta V_{IO}$)	V_{IC} = 1 V, V_O = 1 V, R_S = 50 Ω	25°C	70	94		70	94		dB
			Full range	65			65			
$I_{I(SEL)}$	Bias select current	$V_{I(SEL)}$ = 0	25°C		−100			−130		nA
I_{DD}	Supply current	V_O = 1 V, V_{IC} = 1 V, No load	25°C		65	250		105	280	µA
			Full range			360			400	

† Full range is −40°C to 85°C.

NOTES: 4. The typical values of input bias current and input offset current below 5 pA are determined mathematically.
5. This range also applies to each input individually.
6. At V_{DD} = 5 V, V_O = 0.25 V to 2 V; at V_{DD} = 3 V, V_O = 0.5 V to 1.5 V.

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MEDIUM-BIAS MODE

operating characteristics at specified free-air temperature, V_{DD} = 3 V

PARAMETER		TEST CONDITIONS		T_A	TLV2341I			UNIT
					MIN	TYP	MAX	
SR	Slew rate at unity gain	V_{IC} = 1 V, R_L = 100 kΩ, See Figure 92	$V_{I(PP)}$ = 1 V, C_L = 20 pF,	25°C		0.38		V/μs
				85°C		0.29		
V_n	Equivalent input noise voltage	f = kHz, See Figure 93	R_S = 20 Ω,	25°C		32		nV/√Hz
B_{OM}	Maximum output-swing bandwidth	V_O = V_{OH}, R_L = 100 kΩ,	C_L = 20 pF, See Figure 92	25°C		34		kHz
				85°C		32		
B_1	Unity-gain bandwidth	V_I = 10 mV, R_L = 100 kΩ,	C_L = 20 pF, See Figure 94	25°C		300		kHz
				85°C		235		
ϕ_m	Phase margin	V_I = 10 mV, C_L = 20 pF, See Figure 94	f = B_1, R_L = 100 kΩ,	−40°C		42°		
				25°C		39°		
				85°C		36°		

operating characteristics at specified free-air temperature, V_{DD} = 5 V

PARAMETER		TEST CONDITIONS		T_A	TLV2341I			UNIT
					MIN	TYP	MAX	
SR	Slew rate at unity gain	V_{IC} = 1 V, R_L = 100 kΩ, C_L = 20 pF, See Figure 92	$V_{I(PP)}$ = 1 V	25°C		0.43		V/μs
				85°C		0.35		
			$V_{I(PP)}$ = 2.5 V	25°C		0.40		
				85°C		0.32		
V_n	Equivalent input noise voltage	f =1 kHz, See Figure 93	R_S = 20 Ω,	25°C		32		nV/√Hz
B_{OM}	Maximum output-swing bandwidth	V_O = V_{OH}, R_L = 100 kΩ,	C_L = 20 pF, See Figure 92	25°C		55		kHz
				85°C		45		
B_1	Unity-gain bandwidth	V_I = 10 mV, R_L = 100 kΩ,	C_L = 20 pF, See Figure 94	25°C		525		kHz
				85°C		370		
ϕ_m	Phase margin	V_I = 10 mV, C_L = 20 pF, See Figure 94	f = B_1, R_L = 100 kΩ,	−40°C		43°		
				25°C		40°		
				85°C		38°		

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MEDIUM-BIAS MODE

electrical characteristics, T_A = 25°C

PARAMETER		TEST CONDITIONS		TLV2341I						UNIT
				V_{DD} = 3 V			V_{DD} = 5 V			
				MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	Input offset voltage	V_O = 1 V, R_S = 50 Ω,	V_{IC} = 1 V, R_L = 100 kΩ		0.6	8		1.1	8	mV
I_{IO}	Input offset current (see Note 4)	V_O = 1 V,	V_{IC} = 1 V		0.1			0.1		pA
I_{IB}	Input bias current (see Note 4)	V_O = 1 V,	V_{IC} = 1 V		0.6			0.6		pA
V_{ICR}	Common-mode input voltage range (see Note 5)			−0.2 to 2	−0.3 to 2.3		−0.2 to 4	−0.3 to 4.2		V
V_{OH}	High-level output voltage	V_{IC} = 1 V, I_{OH} = −1 mA	V_{ID} = 100 mV,	1.75	1.9		3.2	3.9		V
V_{OL}	Low-level output voltage	V_{IC} = 1 V, I_{OL} = 1 mA	V_{ID} = −100 mV,		115	150		95	150	mV
A_{VD}	Large-signal differential voltage amplification	V_{IC} = 1 V, See Note 6	R_L = 100 kΩ,	25	83		25	170		V/mV
CMRR	Common-mode rejection ratio	V_O = 1 V, R_S = 50 Ω	V_{IC} = V_{ICR}min,	65	92		65	91		dB
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{DD}/\Delta V_{ID}$)	V_O = 1 V, R_S = 50 Ω	V_{IC} = 1 V,	70	94		70	94		dB
$I_{I(SEL)}$	Bias select current	$V_{I(SEL)}$ = 0			−100			−130		nA
I_{DD}	Supply current	V_O = 1 V, No load	V_{IC} = 1 V,		65	250		105	280	μA

NOTES: 4. The typical values of input bias current and input offset current below 5 pA are determined mathematically.
5. This range also applies to each input individually.
6. At V_{DD} = 5 V, V_O = 0.25 V to 2 V; at V_{DD} = 3 V, V_O = 0.5 V to 1.5 V.

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TYPICAL CHARACTERISTICS (MEDIUM-BIAS MODE)

Table of Graphs

			FIGURE
V_{IO}	Input offset voltage	Distribution	32, 33
α_{VIO}	Input offset voltage temperature coefficient	Distribution	34, 35
V_{OH}	High-level output voltage	vs Output current vs Supply voltage vs Temperature	36 37 38
V_{OL}	Low-level output voltage	vs Common-mode input voltage vs Temperature vs Differential input voltage vs Low-level output current	39 40, 42 41 43
A_{VD}	Large-signal differential voltage amplification	vs Supply voltage vs Temperature vs Frequency	44 45 56, 57
I_{IB}	Input bias current	vs Temperature	46
I_{IO}	Input offset current	vs Temperature	46
V_{IC}	Common-mode input voltage	vs Supply voltage	47
I_{DD}	Supply current	vs Supply voltage vs Temperature	48 49
SR	Slew rate	vs Supply voltage vs Temperature	50 51
	Bias select current	vs Supply current	52
$V_{O(PP)}$	Maximum peak-to-peak output voltage	vs Frequency	53
B_1	Unity-gain bandwidth	vs Temperature vs Supply voltage	54 55
ϕ_m	Phase margin	vs Supply voltage vs Temperature vs Load capacitance	58 59 60
V_n	Equivalent input noise voltage	vs Frequency	61
	Phase shift	vs Frequency	56, 57

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TYPICAL CHARACTERISTICS (MEDIUM-BIAS MODE)

DISTRIBUTION OF TLV2341
INPUT OFFSET VOLTAGE

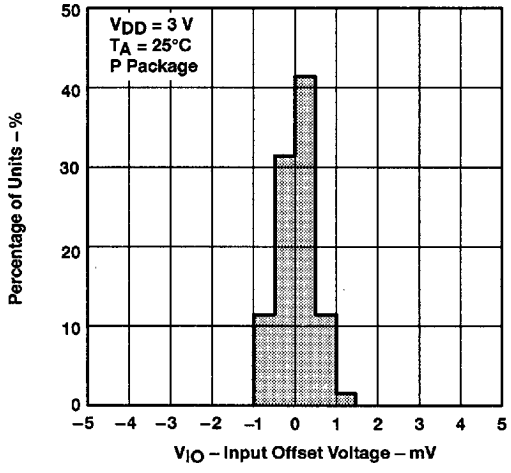

Figure 32

DISTRIBUTION OF TLV2341
INPUT OFFSET VOLTAGE

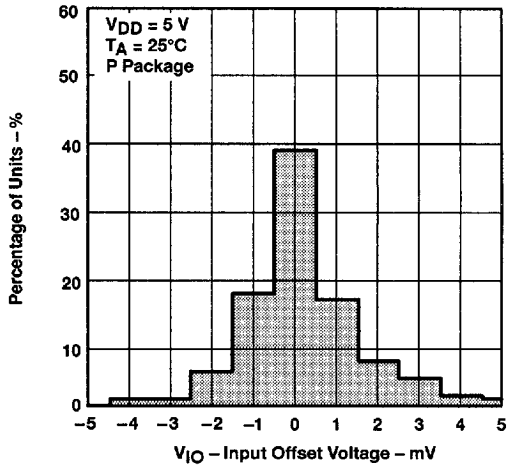

Figure 33

DISTRIBUTION OF TLV2341
INPUT OFFSET VOLTAGE
TEMPERATURE COEFFICIENT

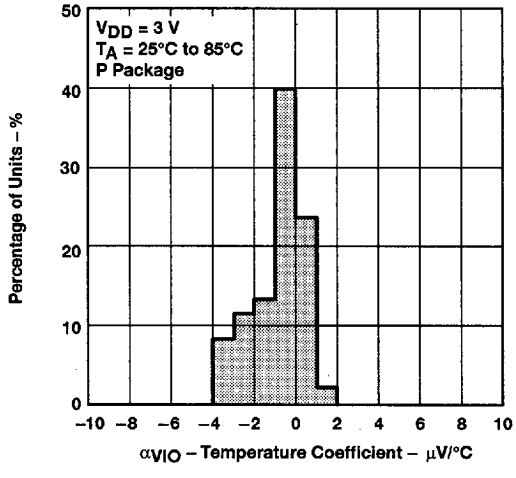

Figure 34

DISTRIBUTION OF TLV2341
INPUT OFFSET VOLTAGE
TEMPERATURE COEFFICIENT

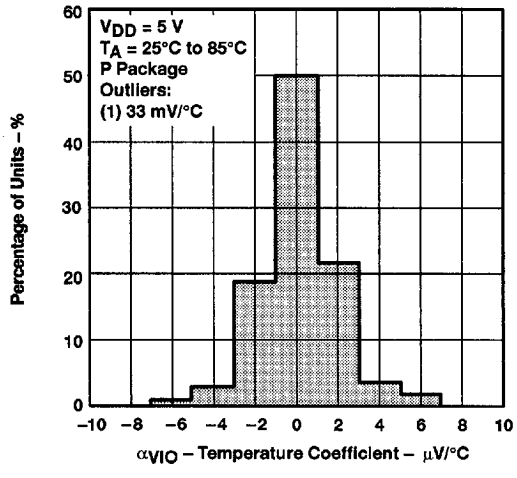

Figure 35

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TYPICAL CHARACTERISTICS (MEDIUM-BIAS MODE)

HIGH-LEVEL OUTPUT VOLTAGE
vs
HIGH-LEVEL OUTPUT CURRENT

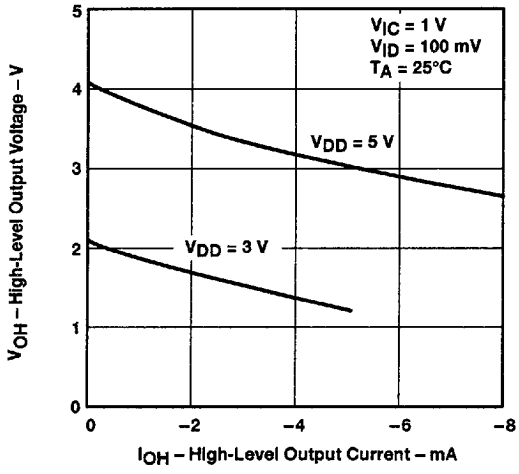

Figure 36

HIGH-LEVEL OUTPUT VOLTAGE
vs
SUPPLY VOLTAGE

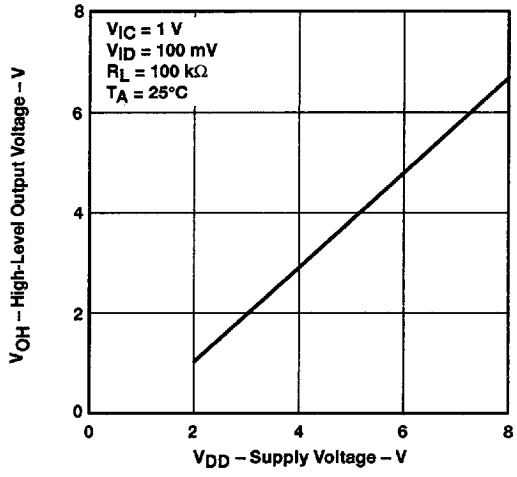

Figure 37

HIGH-LEVEL OUTPUT VOLTAGE
vs
FREE-AIR TEMPERATURE

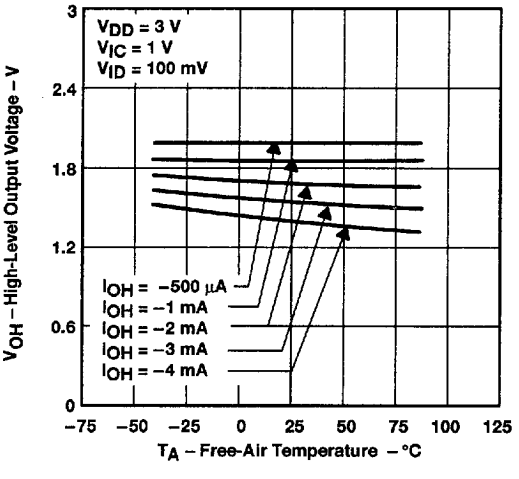

Figure 38

LOW-LEVEL OUTPUT VOLTAGE
vs
COMMON-MODE INPUT VOLTAGE

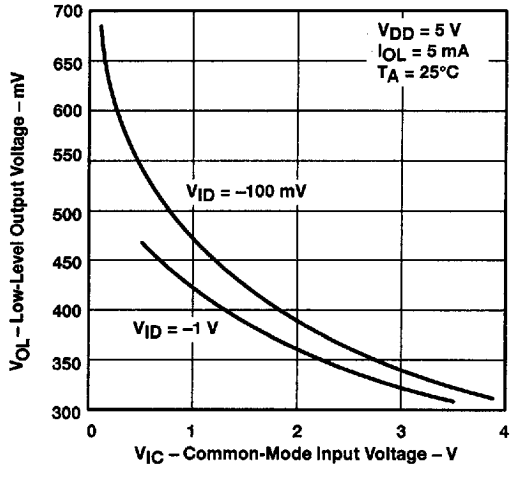

Figure 39

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TYPICAL CHARACTERISTICS (MEDIUM-BIAS MODE)

LOW-LEVEL OUTPUT VOLTAGE
vs
FREE-AIR TEMPERATURE

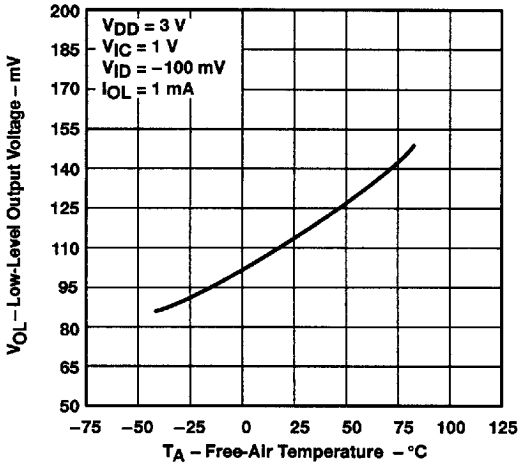

Figure 40

LOW-LEVEL OUTPUT VOLTAGE
vs
DIFFERENTIAL INPUT VOLTAGE

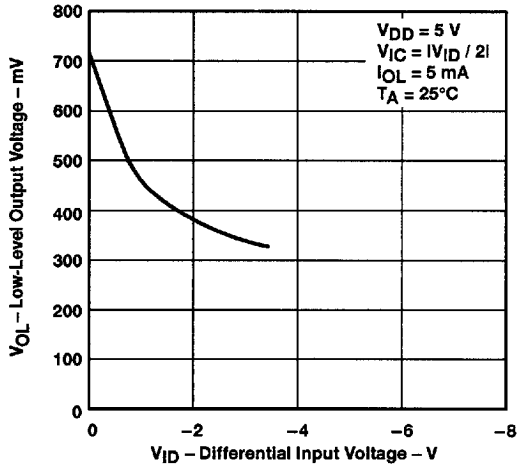

Figure 41

LOW-LEVEL OUTPUT VOLTAGE
vs
FREE-AIR TEMPERATURE

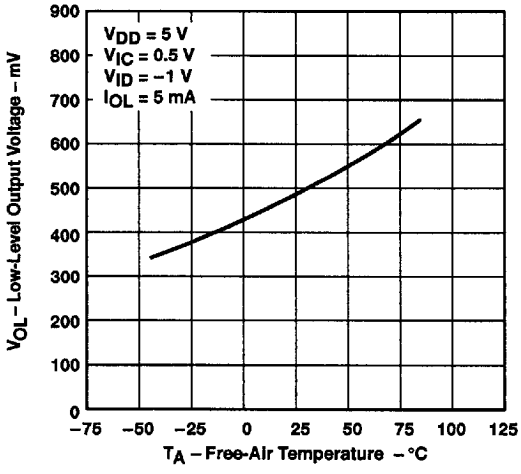

Figure 42

LOW-LEVEL OUTPUT VOLTAGE
vs
LOW-LEVEL OUTPUT CURRENT

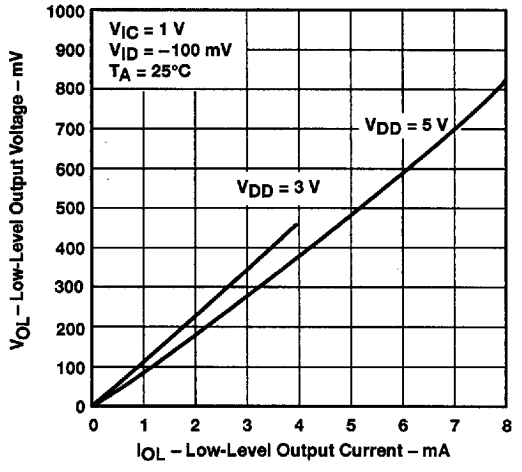

Figure 43

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TYPICAL CHARACTERISTICS (MEDIUM-BIAS MODE)

LARGE-SIGNAL
DIFFERENTIAL VOLTAGE AMPLIFICATION
vs
SUPPLY VOLTAGE

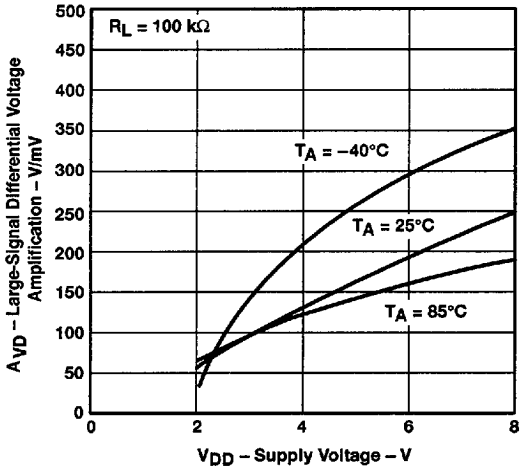


Figure 44

LARGE-SIGNAL
DIFFERENTIAL VOLTAGE AMPLIFICATION
vs
FREE-AIR TEMPERATURE

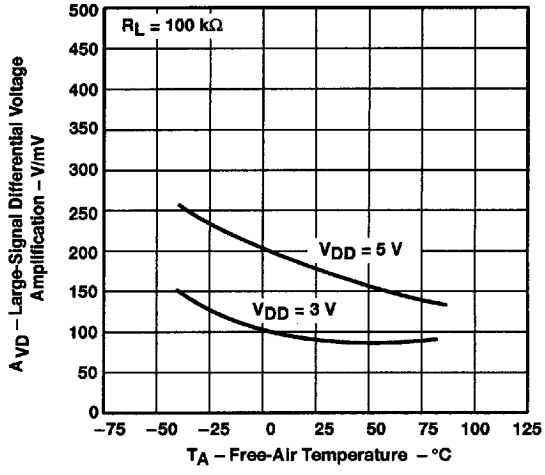
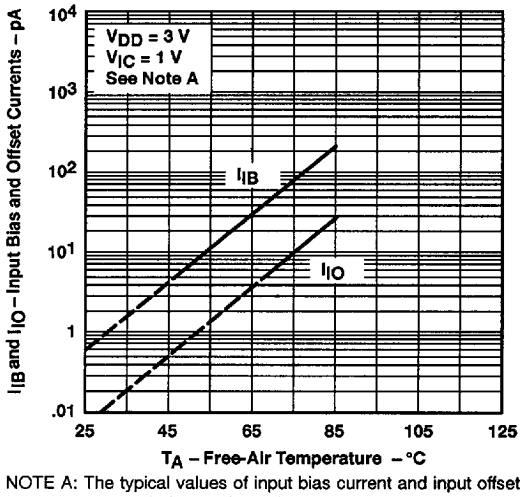


Figure 45

INPUT BIAS CURRENT AND INPUT
OFFSET CURRENT
vs
FREE-AIR TEMPERATURE



NOTE A: The typical values of input bias current and input offset current below 5 pA are determined mathematically.

Figure 46

COMMON-MODE INPUT VOLTAGE
POSITIVE LIMIT
vs
SUPPLY VOLTAGE

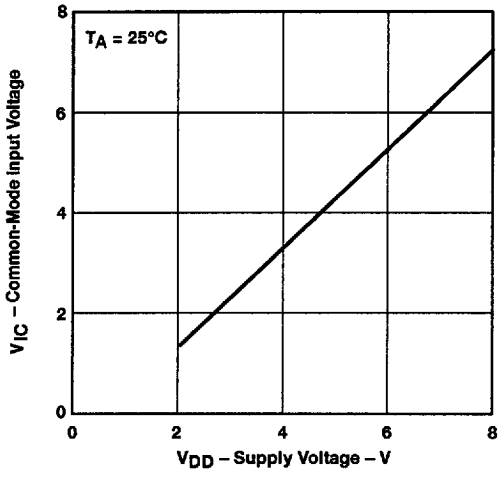


Figure 47

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TYPICAL CHARACTERISTICS (MEDIUM-BIAS MODE)

SUPPLY CURRENT vs SUPPLY VOLTAGE

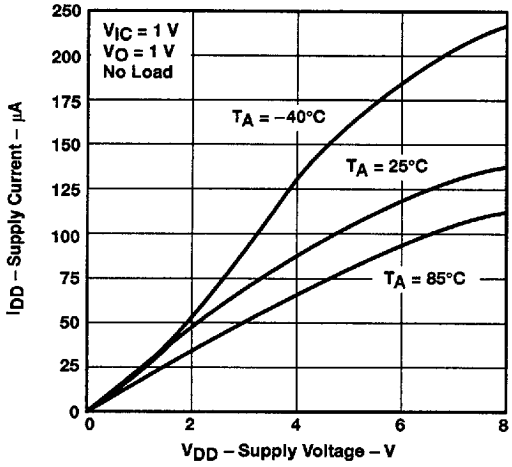

Figure 48

SUPPLY CURRENT vs FREE-AIR TEMPERATURE

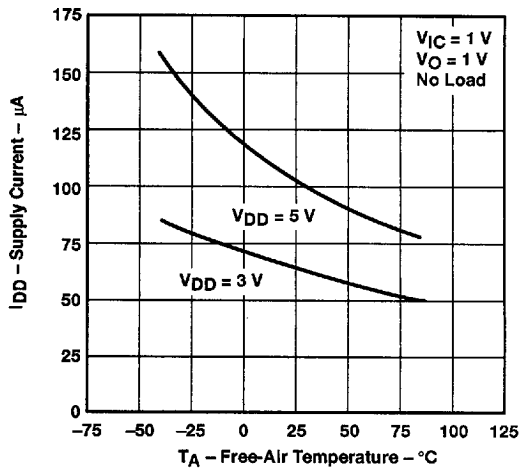

Figure 49

SLEW RATE vs SUPPLY VOLTAGE

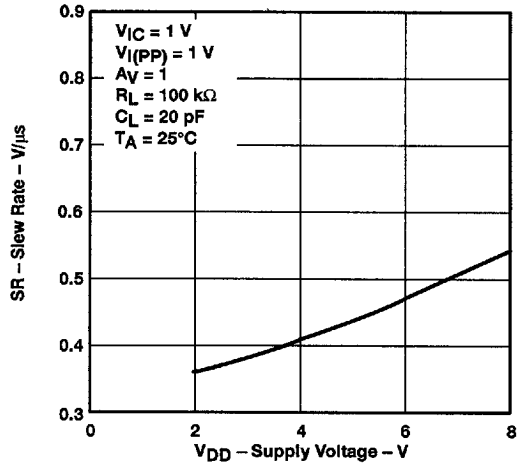

Figure 50

SLEW RATE vs FREE-AIR TEMPERATURE

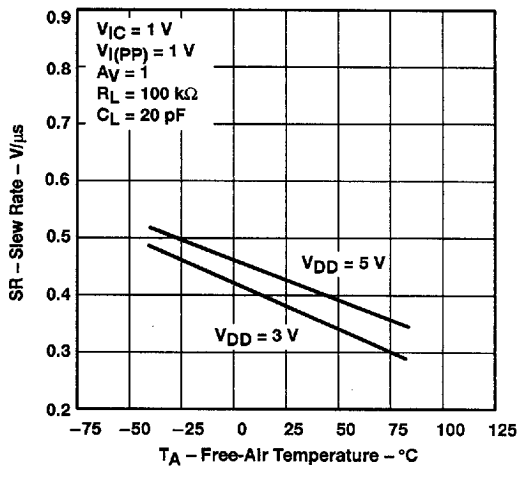

Figure 51

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TYPICAL CHARACTERISTICS (MEDIUM-BIAS MODE)

BIAS SELECT CURRENT vs SUPPLY VOLTAGE

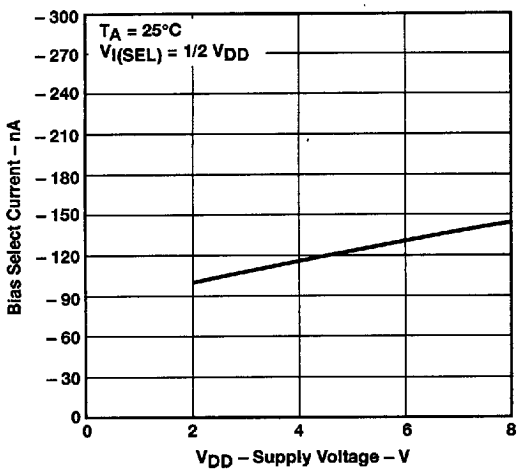

Figure 52

MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE vs FREQUENCY

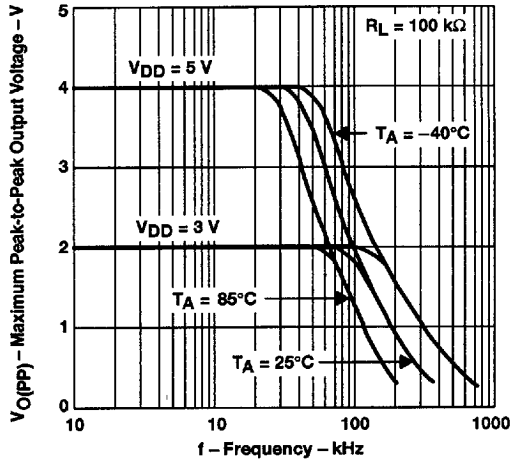

Figure 53

UNITY-GAIN BANDWIDTH vs FREE-AIR TEMPERATURE

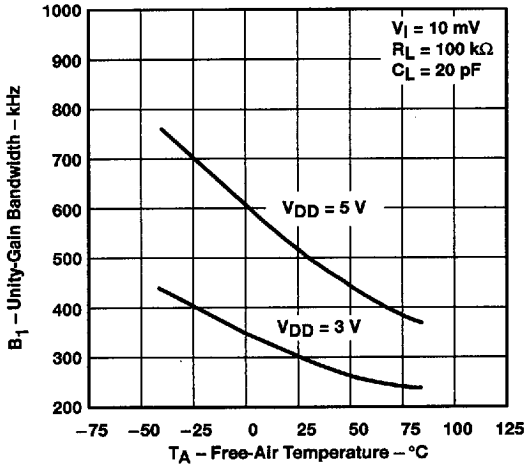

Figure 54

UNITY-GAIN BANDWIDTH vs SUPPLY VOLTAGE

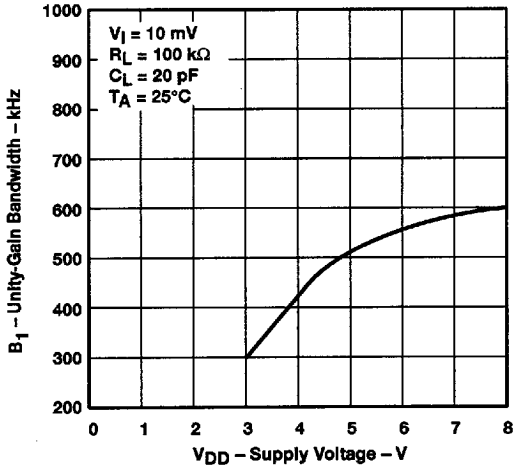

Figure 55

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TYPICAL CHARACTERISTICS (MEDIUM-BIAS MODE)

LARGE-SIGNAL DIFFERENTIAL VOLTAGE
AMPLIFICATION AND PHASE SHIFT
vs
FREQUENCY

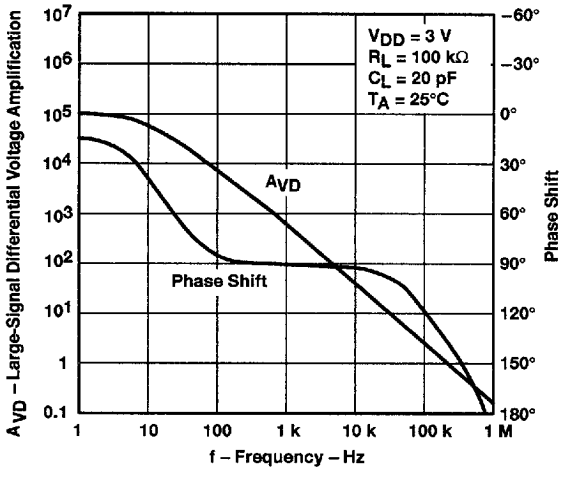

Figure 56

LARGE-SIGNAL DIFFERENTIAL VOLTAGE
AMPLIFICATION AND PHASE SHIFT
vs
FREQUENCY

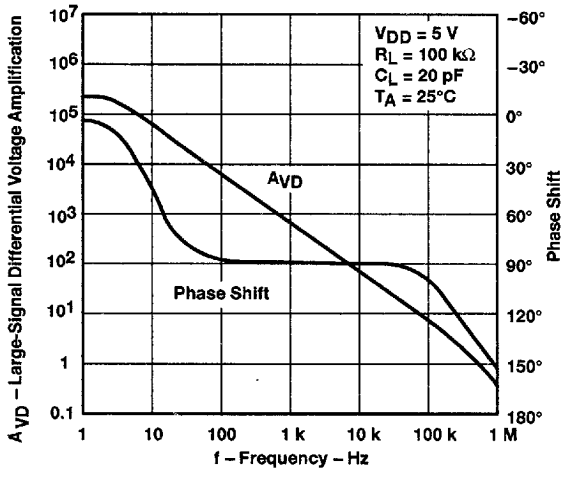

Figure 57

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TYPICAL CHARACTERISTICS (MEDIUM-BIAS MODE)

PHASE MARGIN
vs
SUPPLY VOLTAGE

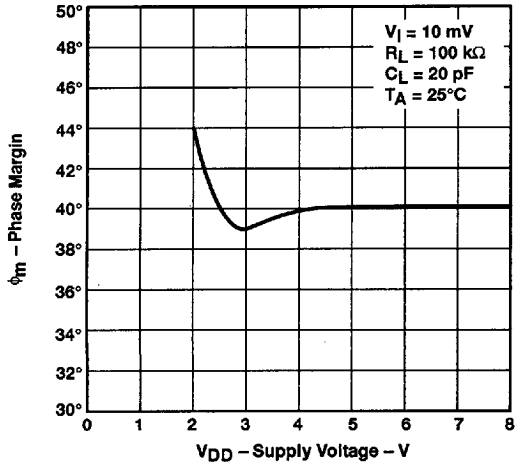

Figure 58

PHASE MARGIN
vs
FREE-AIR TEMPERATURE

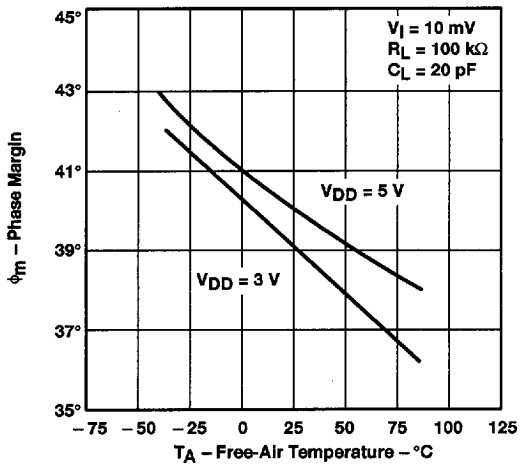

Figure 59

PHASE MARGIN
vs
LOAD CAPACITANCE

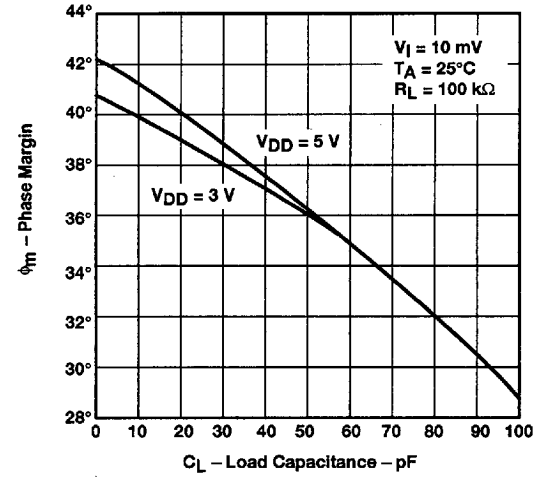

Figure 60

EQUIVALENT INPUT NOISE VOLTAGE
vs
FREQUENCY

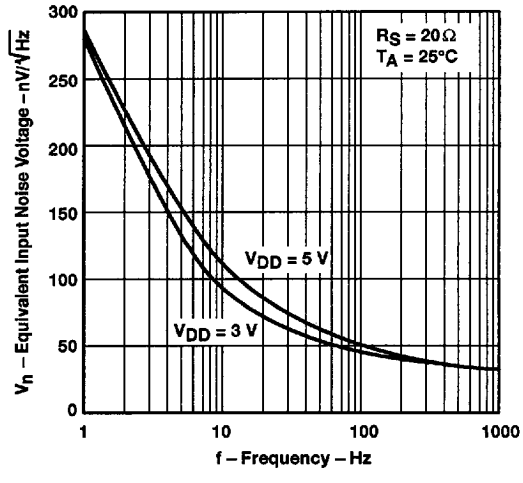

Figure 61

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LOW-BIAS MODE

electrical characteristics at specified free-air temperature

PARAMETER		TEST CONDITIONS	T_A†	TLV2341I						UNIT
				V_{DD} = 3 V			V_{DD} = 5 V			
				MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	Input offset voltage	V_O = 1 V, V_{IC} = 1 V, R_S = 50 Ω, R_L = 1 MΩ	25°C		0.6	8		1.1	8	mV
			Full range			10			10	
α_{VIO}	Average temperature of input offset voltage		25°C to 85°C		1			1.1		μV/°C
I_{IO}	Input offset current (see Note 4)	V_O = 1 V, V_{IC} = 1 V	25°C		0.1			0.1		pA
			85°C		22	1000		24	1000	
I_{IB}	Input bias current (see Note 4)	V_O = 1 V, V_{IC} = 1 V	25°C		0.6			0.6		pA
			85°C		175	2000		200	2000	
V_{ICR}	Common-mode input voltage range (see Note 5)		25°C	−0.2 to 2	−0.3 to 2.3		−0.2 to 4	−0.3 to 4.2		V
			Full range	−0.2 to 1.8			−0.2 to 3.8			V
V_{OH}	High-level output voltage	V_{IC} = 1 V, V_{ID} = 100 mV, I_{OH} = −1 mA	25°C	1.75	1.9		3.2	3.8		V
			Full range	1.7			3			
V_{OL}	Low-level output voltage	V_{IC} = 1 V, V_{ID} = −100 mV, I_{OL} = 1 mA	25°C		115	150		95	150	mV
			Full range			190			190	
A_{VD}	Large-signal differential voltage amplification	V_{IC} = 1 V, R_L = 1 MΩ, See Note 6	25°C	50	400		50	520		V/mV
			Full range	50			50			
CMRR	Common-mode rejection ratio	V_O = 1 V, V_{IC} = V_{ICR}min, R_S = 50 Ω	25°C	65	88		65	94		dB
			Full range	60			60			
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{DD}/\Delta V_{IO}$)	V_{IC} = 1 V, V_O = 1 V, R_S = 50 Ω	25°C	70	86		70	86		dB
			Full range	65			65			
$I_{I(SEL)}$	Bias select current	$V_{I(SEL)}$ = 0	25°C		10			65		nA
I_{DD}	Supply current	V_O = 1 V, V_{IC} = 1 V, No load	25°C		5	17		10	17	μA
			Full range			27			27	

† Full range is −40°C to 85°C.

NOTES: 4. The typical values of input bias current and input offset current below 5 pA are determined mathematically.
5. This range also applies to each input individually.
6. At V_{DD} = 5 V, $V_{O(PP)}$ = 0.25 V to 2 V; at V_{DD} = 3 V, V_O = 0.5 V to 1.5 V.

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LOW-BIAS MODE

operating characteristics at specified free-air temperature, V_{DD} = 3 V

PARAMETER		TEST CONDITIONS		T_A	TLV2341I			UNIT
					MIN	TYP	MAX	
SR	Slew rate at unity gain	V_{IC} = 1 V, R_L = 1 MΩ, See Figure 92	$V_{I(PP)}$ = 1 V, C_L = 20 pF,	25°C		0.02		V/μs
				85°C		0.02		
V_n	Equivalent input noise voltage	f = kHz, See Figure 93	R_S = 20 Ω,	25°C		68		nV/√Hz
B_{OM}	Maximum output-swing bandwidth	V_O = V_{OH}, R_L = 1 MΩ,	C_L = 20 pF, See Figure 92	25°C		2.5		kHz
				85°C		2		
B_1	Unity-gain bandwidth	V_I = 10 mV, R_L = 1 MΩ,	C_L = 20 pF, See Figure 94	25°C		27		kHz
				85°C		21		
ϕ_m	Phase margin	V_I = 10 mV, C_L = 20 pF, See Figure 94	f = B_1, R_L = 1 MΩ,	−40°C		39°		
				25°C		34°		
				85°C		28°		

operating characteristics at specified free-air temperature, V_{DD} = 5 V

PARAMETER		TEST CONDITIONS		T_A	TLV2341I			UNIT
					MIN	TYP	MAX	
SR	Slew rate at unity gain	V_{IC} = 1 V, R_L = 1 MΩ, C_L = 20 pF, See Figure 92	$V_{I(PP)}$ = 1 V	25°C		0.03		V/μs
				85°C		0.03		
			$V_{I(PP)}$ = 2.5 V	25°C		0.03		
				85°C		0.02		
V_n	Equivalent input noise voltage	f =1 kHz, See Figure 93	R_S = 20 Ω,	25°C		68		nV/√Hz
B_{OM}	Maximum output-swing bandwidth	V_O = V_{OH}, R_L = 1 MΩ,	C_L = 20 pF, See Figure 92	25°C		5		kHz
				85°C		4		
B_1	Unity-gain bandwidth	V_I = 10 mV, R_L = 1 MΩ,	C_L = 20 pF, See Figure 94	25°C		85		kHz
				85°C		55		
ϕ_m	Phase margin	V_I = 10 mV, C_L = 20 pF, See Figure 94	f = B_1, R_L = 1 MΩ,	−40°C		38°		
				25°C		34°		
				85°C		28°		

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LOW-BIAS MODE

electrical characteristics, T_A = 25°C

PARAMETER		TEST CONDITIONS		TLV2341Y						UNIT
				V_{DD} = 3 V			V_{DD} = 5 V			
				MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	Input offset voltage	V_O = 1 V, R_S = 50 Ω,	V_{IC} = 1 V, R_L = 1 MΩ		0.6	8		1.1	8	mV
I_{IO}	Input offset current (see Note 4)	V_O = 1 V,	V_{IC} = 1 V		0.1			0.1		pA
I_{IB}	Input bias current (see Note 4)	V_O = 1 V,	V_{IC} = 1 V		0.6			0.6		pA
V_{ICR}	Common-mode input voltage range (see Note 5)			−0.2 to 2	−0.3 to 2.3		−0.2 to 4	−0.3 to 4.2		V
V_{OH}	High-level output voltage	V_{IC} = 1 V, I_{OH} = −1 mA	V_{ID} = 100 mV,	1.75	1.9		3.2	3.8		V
V_{OL}	Low-level output voltage	V_{IC} = 1 V, I_{OL} = 1 mA	V_{ID} = −100 mV,		115	150		95	150	mV
A_{VD}	Large-signal differential voltage amplification	V_{IC} = 1 V, See Note 6	R_L = 1 MΩ,	50	400		50	520		V/mV
CMRR	Common-mode rejection ratio	V_O = 1 V, R_S = 50 Ω	V_{IC} = V_{ICR}min,	65	88		65	94		dB
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{DD}/\Delta V_{ID}$)	V_{DD} = 3 V to 5 V, V_O = 1 V,	V_{IC} = 1 V, R_S = 50 Ω	70	86		70	86		dB
$I_{I(SEL)}$	Bias select current	$V_{I(SEL)}$ = 0			10			65		nA
I_{DD}	Supply current	V_O = 1 V, No load	V_{IC} = 1 V,		5	17		10	17	μA

NOTES: 4. The typical values of input bias current and input offset current below 5 pA are determined mathematically.
5. This range also applies to each input individually.
6. At V_{DD} = 5 V, V_O = 0.25 V to 2 V; at V_{DD} = 3 V, V_O = 0.5 V to 1.5 V.

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TYPICAL CHARACTERISTICS (LOW-BIAS MODE)

Table of Graphs

			FIGURE
V_{IO}	Input offset voltage	Distribution	62, 63
α_{VIO}	Input offset voltage temperature coefficient	Distribution	64, 65
V_{OH}	High-level output voltage	vs Output current vs Supply voltage vs Temperature	66 67 68
V_{OL}	Low-level output voltage	vs Common-mode input voltage vs Temperature vs Differential input voltage vs Low-level output current	69 70, 72 71 73
A_{VD}	Large-signal differential voltage amplification	vs Supply voltage vs Temperature vs Frequency	74 75 86, 87
I_{IB}	Input bias current	vs Temperature	76
I_{IO}	Input offset current	vs Temperature	76
V_{IC}	Common-mode input voltage	vs Supply voltage	77
I_{DD}	Supply current	vs Supply voltage vs Temperature	78 79
SR	Slew rate	vs Supply voltage vs Temperature	80 81
	Bias select current	vs Supply current	82
$V_{O(PP)}$	Maximum peak-to-peak output voltage	vs Frequency	83
B_1	Unity-gain bandwidth	vs Temperature vs Supply voltage	84 85
ϕ_m	Phase margin	vs Supply voltage vs Temperature vs Load capacitance	88 89 90
V_n	Equivalent input noise voltage	vs Frequency	91
	Phase shift	vs Frequency	86, 87

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TYPICAL CHARACTERISTICS (LOW-BIAS MODE)

DISTRIBUTION OF TLV2341
INPUT OFFSET VOLTAGE

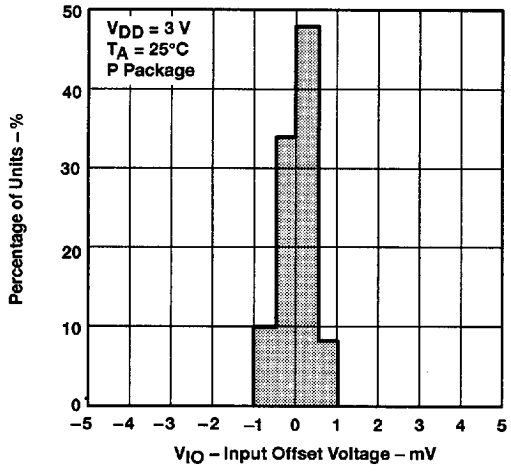

Figure 62

DISTRIBUTION OF TLV2341
INPUT OFFSET VOLTAGE

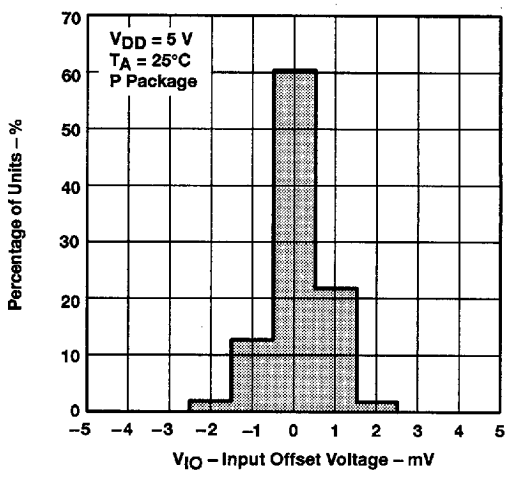

Figure 63

DISTRIBUTION OF TLV2341
INPUT OFFSET VOLTAGE
TEMPERATURE COEFFICIENT

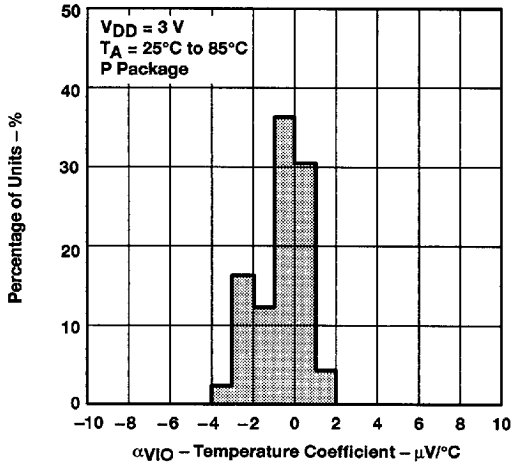

Figure 64

DISTRIBUTION OF TLV2341
INPUT OFFSET VOLTAGE
TEMPERATURE COEFFICIENT

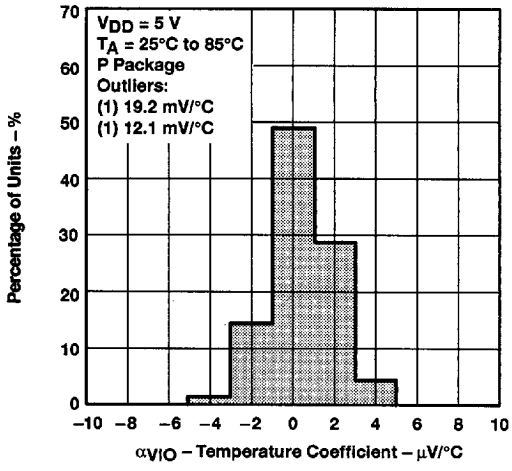

Figure 65

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TYPICAL CHARACTERISTICS (LOW-BIAS MODE)

HIGH-LEVEL OUTPUT VOLTAGE
vs
HIGH-LEVEL OUTPUT CURRENT

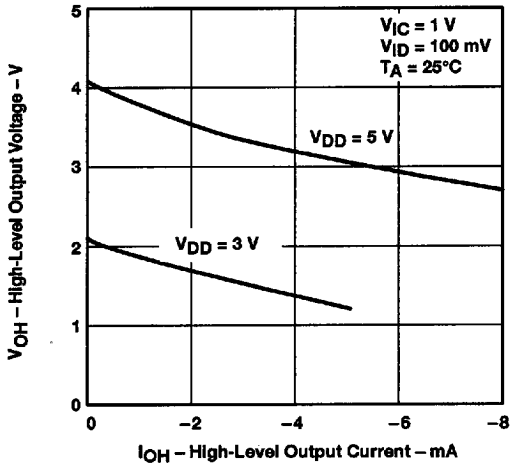

Figure 66

HIGH-LEVEL OUTPUT VOLTAGE
vs
SUPPLY VOLTAGE

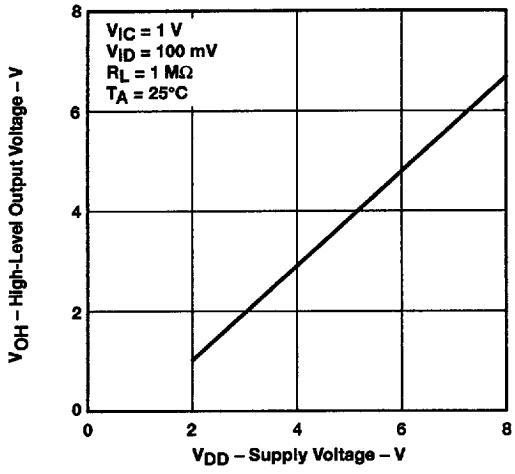

Figure 67

HIGH-LEVEL OUTPUT VOLTAGE
vs
FREE-AIR TEMPERATURE

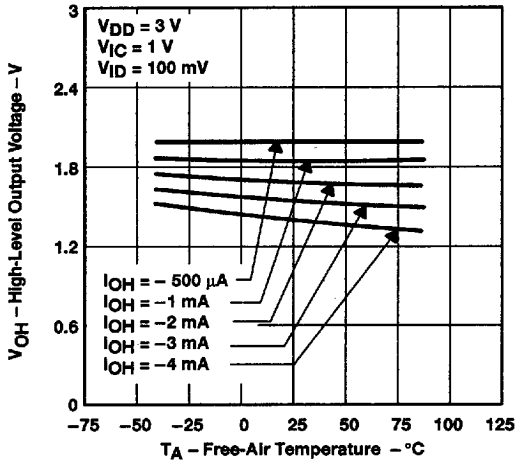

Figure 68

LOW-LEVEL OUTPUT VOLTAGE
vs
COMMON-MODE INPUT VOLTAGE

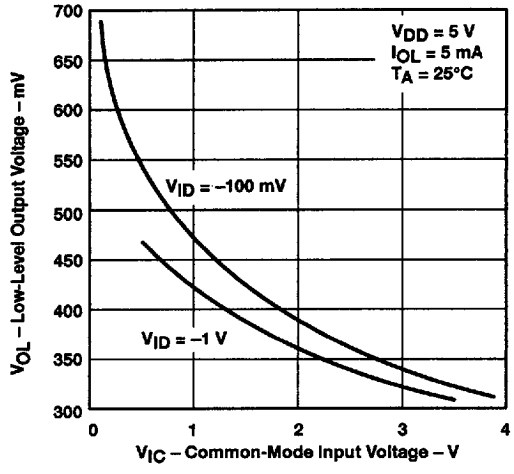

Figure 69

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TYPICAL CHARACTERISTICS (LOW-BIAS MODE)

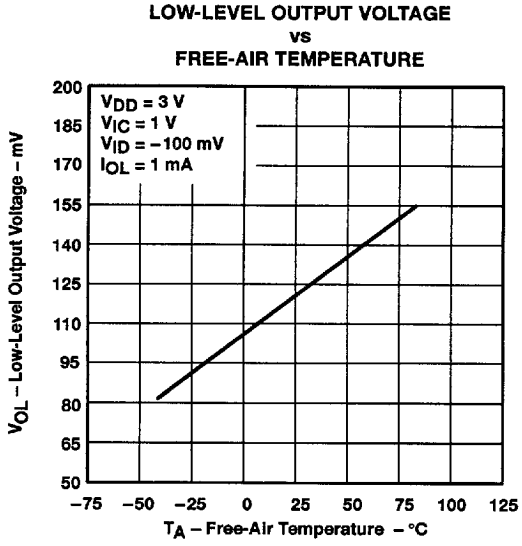

Figure 70

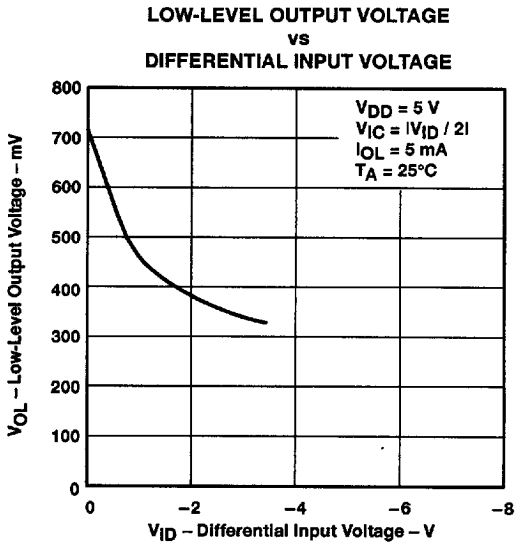

Figure 71

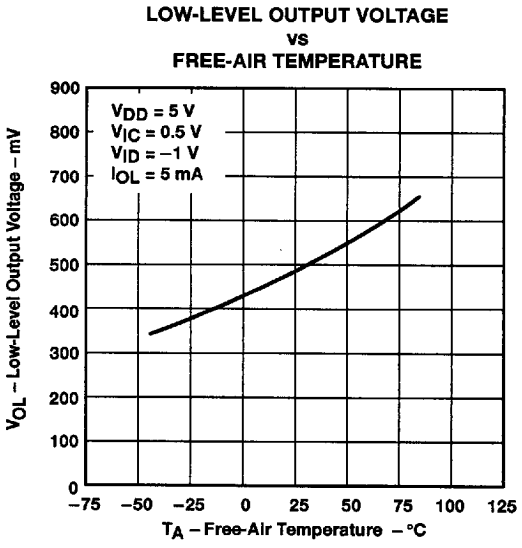

Figure 72

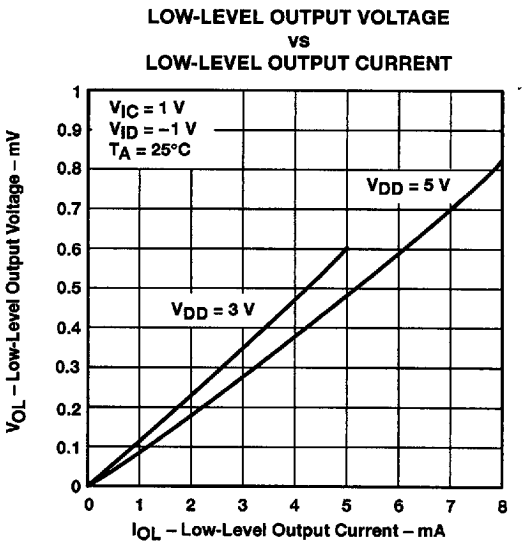

Figure 73

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TYPICAL CHARACTERISTICS (LOW-BIAS MODE)

LARGE-SIGNAL
DIFFERENTIAL VOLTAGE AMPLIFICATION
vs
SUPPLY VOLTAGE

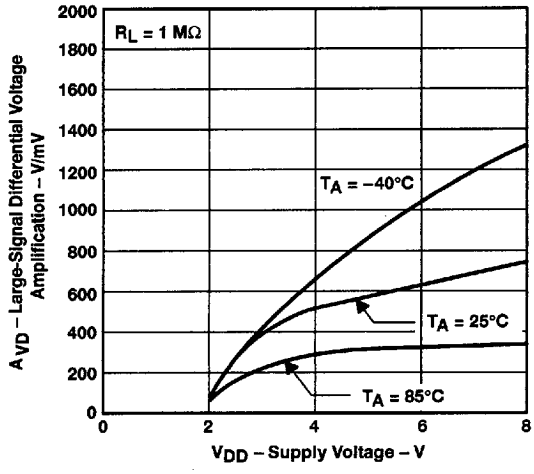


Figure 74

LARGE-SIGNAL
DIFFERENTIAL VOLTAGE AMPLIFICATION
vs
FREE-AIR TEMPERATURE

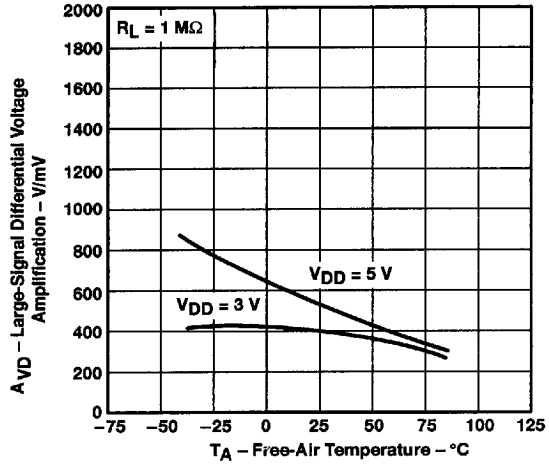
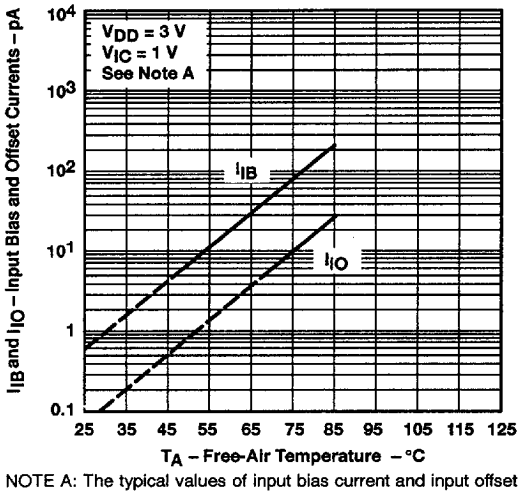


Figure 75

INPUT BIAS CURRENT AND INPUT OFFSET
CURRENT
vs
FREE-AIR TEMPERATURE



NOTE A: The typical values of input bias current and input offset current below 5 pA are determined mathematically.

Figure 76

COMMON-MODE INPUT VOLTAGE
POSITIVE LIMIT
vs
SUPPLY VOLTAGE

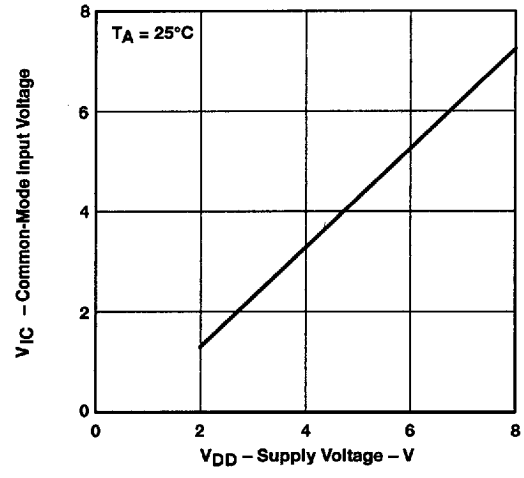


Figure 77

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TYPICAL CHARACTERISTICS (LOW-BIAS MODE)

SUPPLY CURRENT vs SUPPLY VOLTAGE

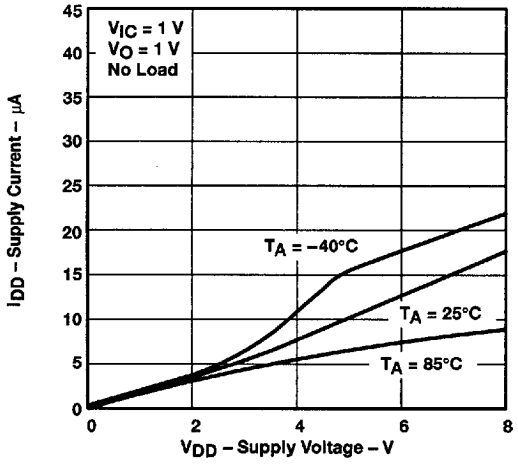

Figure 78

SUPPLY CURRENT vs FREE-AIR TEMPERATURE

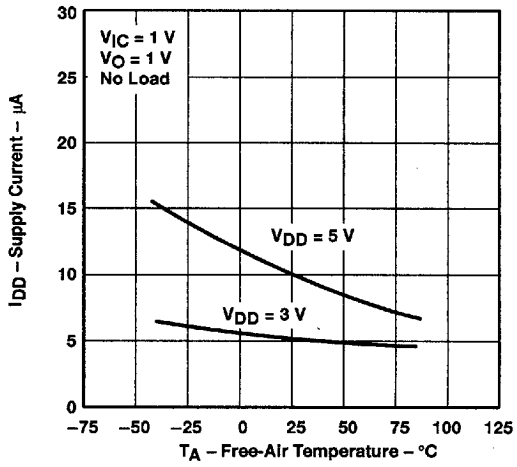

Figure 79

SLEW RATE vs SUPPLY VOLTAGE

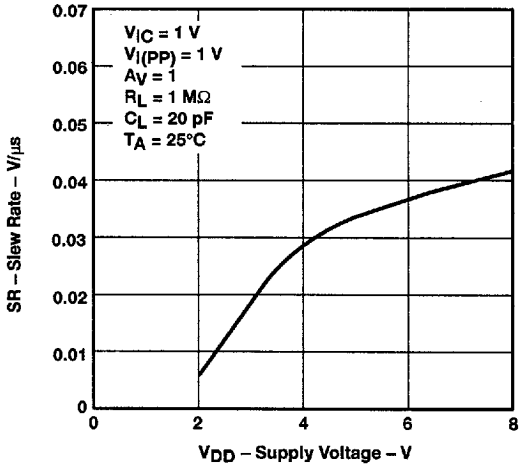

Figure 80

SLEW RATE vs FREE-AIR TEMPERATURE

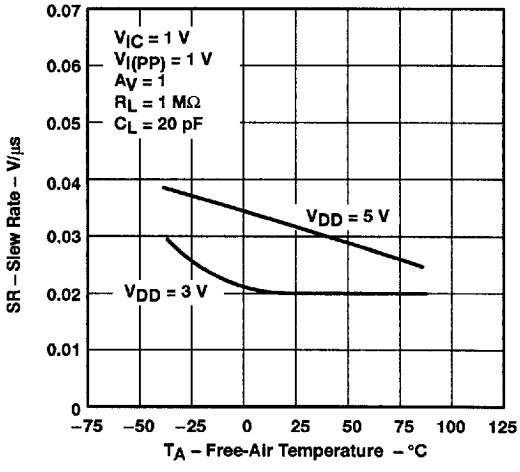

Figure 81

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TYPICAL CHARACTERISTICS (LOW-BIAS MODE)

BIAS SELECT CURRENT
vs
SUPPLY VOLTAGE

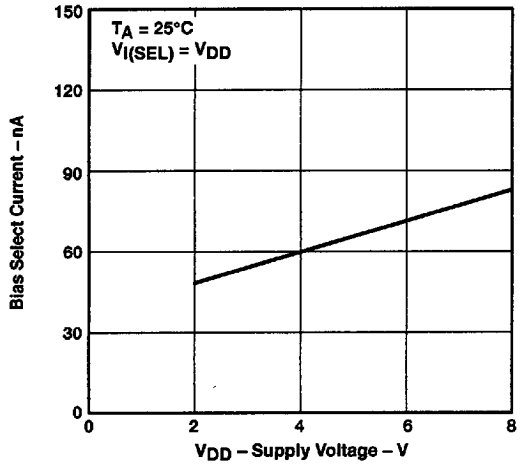

Figure 82

MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE
vs
FREQUENCY

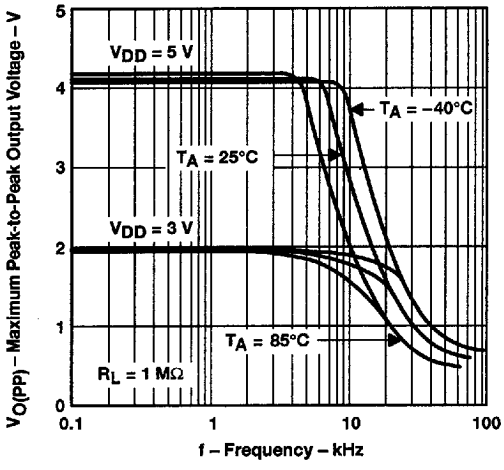

Figure 83

UNITY-GAIN BANDWIDTH
vs
FREE-AIR TEMPERATURE

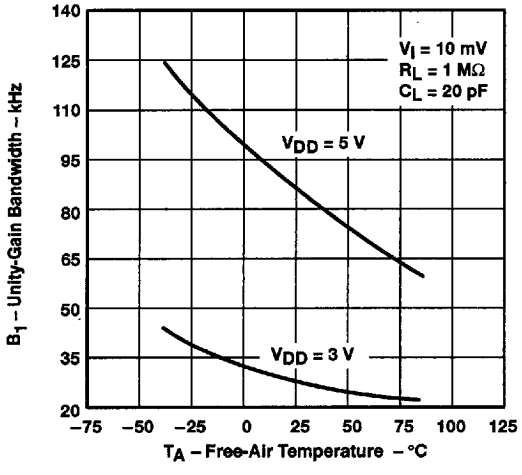

Figure 84

UNITY-GAIN BANDWIDTH
vs
SUPPLY VOLTAGE

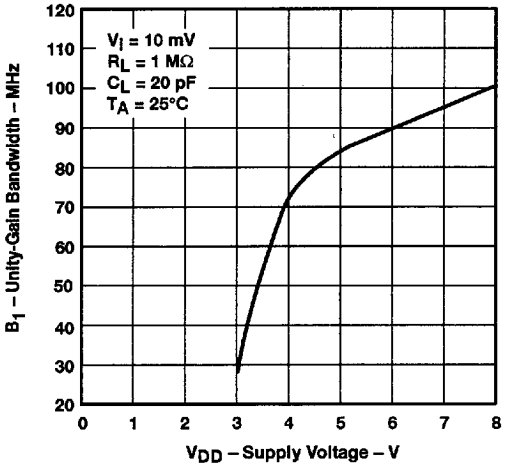

Figure 85

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TYPICAL CHARACTERISTICS (LOW-BIAS MODE)

LARGE-SIGNAL DIFFERENTIAL VOLTAGE
AMPLIFICATION AND PHASE SHIFT
vs
FREQUENCY

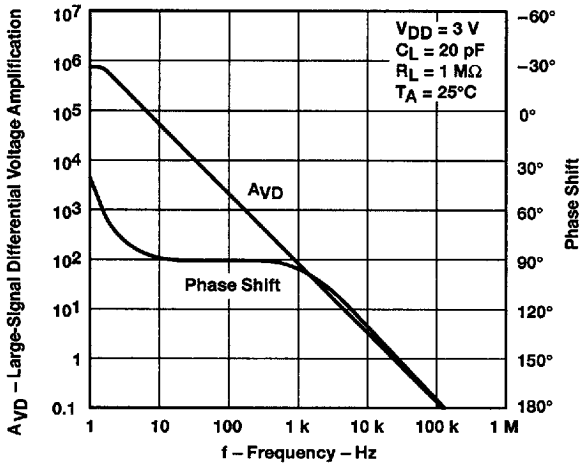

Figure 86

LARGE-SIGNAL DIFFERENTIAL VOLTAGE
AMPLIFICATION AND PHASE SHIFT
vs
FREQUENCY

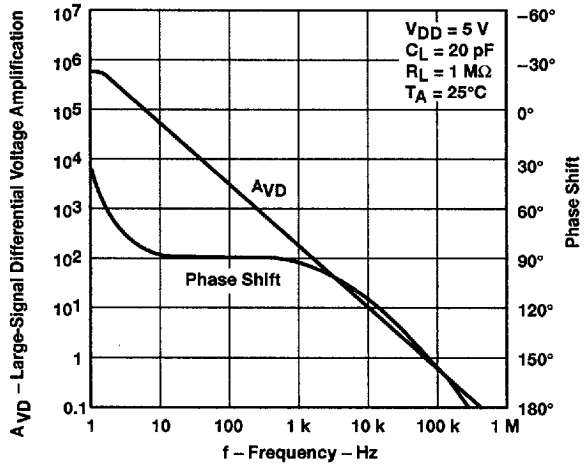

Figure 87

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TYPICAL CHARACTERISTICS (LOW-BIAS MODE)

PHASE MARGIN vs SUPPLY VOLTAGE

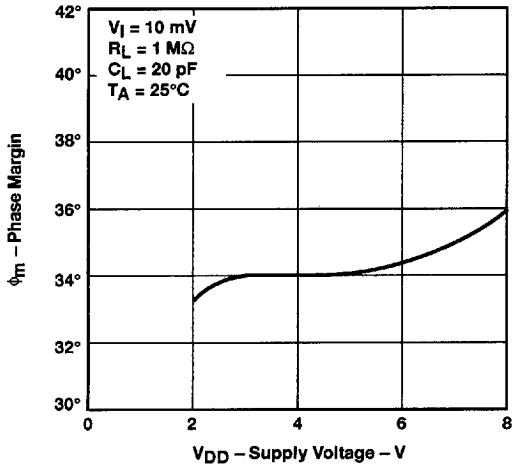

Figure 88

PHASE MARGIN vs FREE-AIR TEMPERATURE

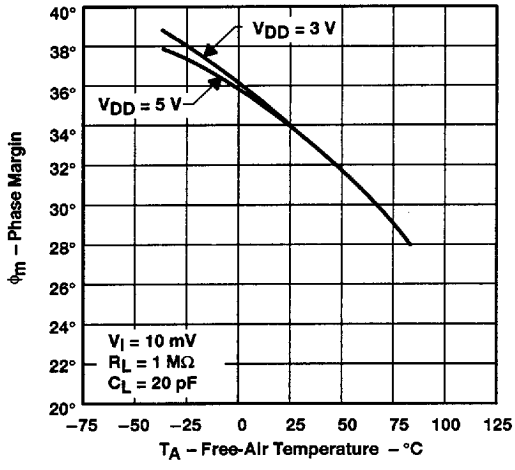

Figure 89

PHASE MARGIN vs LOAD CAPACITANCE

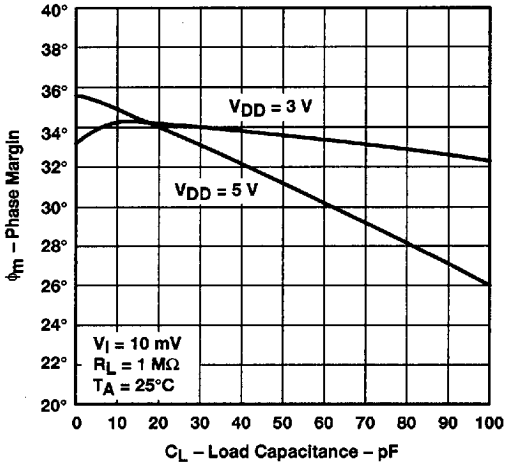

Figure 90

EQUIVALENT INPUT NOISE VOLTAGE vs FREQUENCY

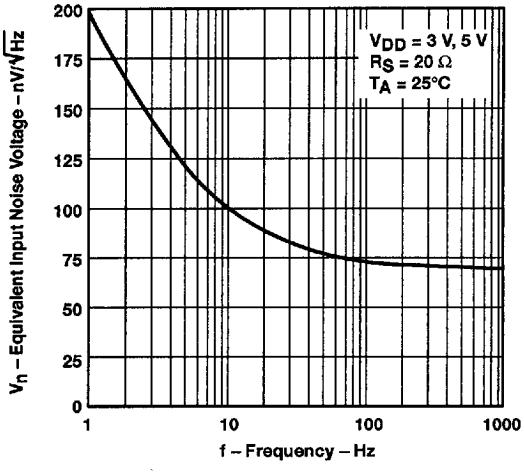

Figure 91

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PARAMETER MEASUREMENT INFORMATION

single-supply versus split-supply test circuits

Because the TLV2341 is optimized for single-supply operation, circuit configurations used for the various tests often present some inconvenience since the input signal, in many cases, must be offset from ground. This inconvenience can be avoided by testing the device with split supplies and the output load tied to the negative rail. A comparison of single-supply versus split-supply test circuits is shown below. The use of either circuit gives the same result.

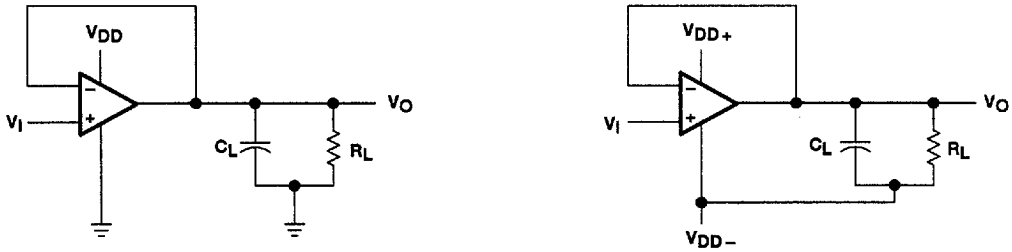

Figure 92. Unity-Gain Amplifier

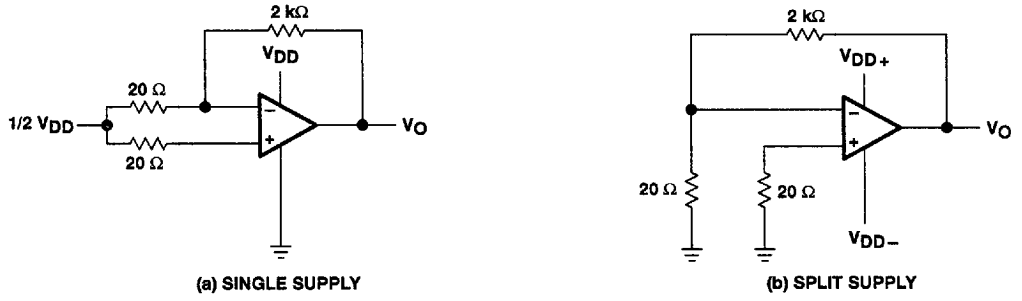

Figure 93. Noise-Test Circuits

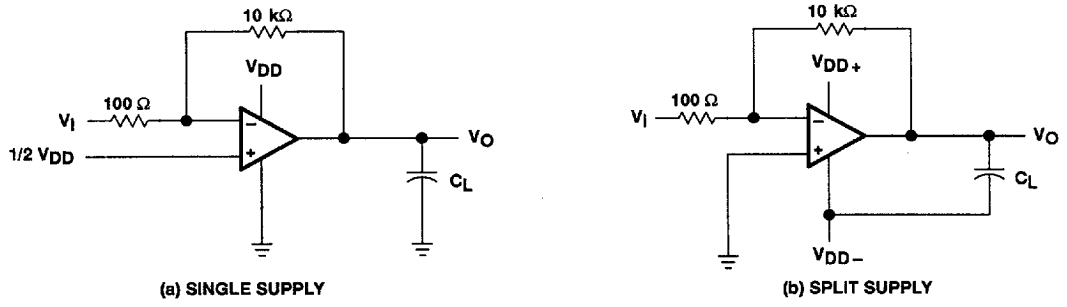

Figure 94. Gain-of-100 Inverting Amplifier

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PARAMETER MEASUREMENT INFORMATION

input bias current

Because of the high input impedance of the TLV2341 operational amplifier, attempts to measure the input bias current can result in erroneous readings. The bias current at normal ambient temperature is typically less than 1 pA, a value that is easily exceeded by leakages on the test socket. Two suggestions are offered to avoid erroneous measurements:

- Isolate the device from other potential leakage sources. Use a grounded shield around and between the device inputs (see Figure 95). Leakages that would otherwise flow to the inputs are shunted away.
- Compensate for the leakage of the test socket by actually performing an input bias current test (using a picoammeter) with no device in the test socket. The actual input bias current can then be calculated by subtracting the open-socket leakage readings from the readings obtained with a device in the test socket.

  Many automatic testers as well as some bench-top operational amplifier testers use the servo-loop technique with a resistor in series with the device input to measure the input bias current (the voltage drop across the series resistor is measured and the bias current is calculated). This method requires that a device be inserted into the test socket to obtain a correct reading; therefore, an open-socket reading is not feasible using this method.

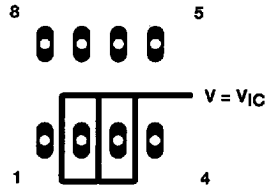

Figure 95. Isolation Metal Around Device Inputs (P package)

low-level output voltage

To obtain low-level supply-voltage operation, some compromise is necessary in the input stage. This compromise results in the device low-level output voltage being dependent on both the common-mode input voltage level as well as the differential input voltage level. When attempting to correlate low-level output readings with those quoted in the electrical specifications, these two conditions should be observed. If conditions other than these are to be used, please refer to the Typical Characteristics section of this data sheet.

input offset voltage temperature coefficient

Erroneous readings often result from attempts to measure temperature coefficient of input offset voltage. This parameter is actually a calculation using input offset voltage measurements obtained at two different temperatures. When one (or both) of the temperatures is below freezing, moisture can collect on both the device and the test socket. This moisture results in leakage and contact resistance which can cause erroneous input offset voltage readings. The isolation techniques previously mentioned have no effect on the leakage since the moisture also covers the isolation metal itself, thereby rendering it useless. These measurements should be performed at temperatures above freezing to minimize error.

full-power response

Full-power response, the frequency above which the operational amplifier slew rate limits the output voltage swing, is often specified two ways: full-linear response and full-peak response. The full-linear response is

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PARAMETER MEASUREMENT INFORMATION

generally measured by monitoring the distortion level of the output while increasing the frequency of a sinusoidal input signal until the maximum frequency is found above which the output contains significant distortion. The full-peak response is defined as the maximum output frequency, without regard to distortion, above which full peak-to-peak output swing cannot be maintained.

Because there is no industry-wide accepted value for significant distortion, the full-peak response is specified in this data sheet and is measured using the circuit of Figure 92. The initial setup involves the use of a sinusoidal input to determine the maximum peak-to-peak output of the device (the amplitude of the sinusoidal wave is increased until clipping occurs). The sinusoidal wave is then replaced with a square wave of the same amplitude. The frequency is then increased until the maximum peak-to-peak output can no longer be maintained (Figure 96). A square wave is used to allow a more accurate determination of the point at which the maximum peak-to-peak output is reached.

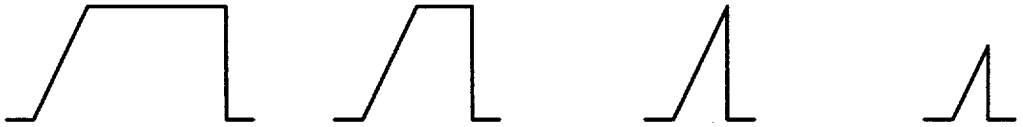

Figure 96. Full-Power-Response Output Signal

test time

Inadequate test time is a frequent problem, especially when testing CMOS devices in a high-volume, short-test-time environment. Internal capacitances are inherently higher in CMOS than in bipolar and BiFET devices and require longer test times than their bipolar and BiFET counterparts. The problem becomes more pronounced with reduced supply levels and lower temperatures.

APPLICATION INFORMATION

single-supply operation

While the TLV2341 performs well using dual-power supplies (also called balanced or split supplies), the design is optimized for single-supply operation. This includes an input common-mode voltage range that encompasses ground as well as an output voltage range that pulls down to ground. The supply voltage range extends down to 2 V, thus allowing operation with supply levels commonly available for TTL and HCMOS.

Many single-supply applications require that a voltage be applied to one input to establish a reference level that is above ground. This virtual ground can be generated using two large resistors, but a preferred technique is to use a virtual-ground generator such as the TLE2426. The TLE2426 supplies an accurate voltage equal to $V_{DD}/2$, while consuming very little power and is suitable for supply voltages of greater than 4 V.

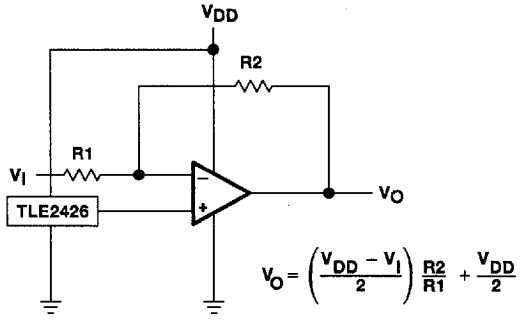

Figure 97. Inverting Amplifier With Voltage Reference

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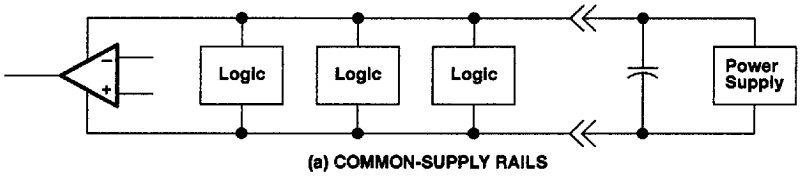
APPLICATION INFORMATION

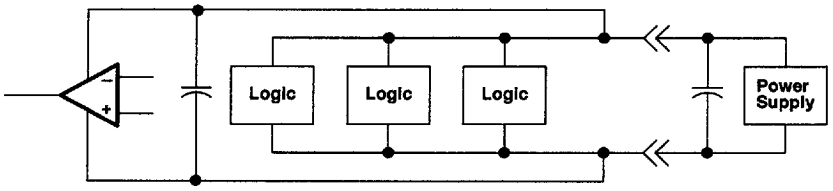
single-supply operation (continued)

The TLV2341 works well in conjunction with digital logic; however, when powering both linear devices and digital logic from the same power supply, the following precautions are recommended:

- Power the linear devices from separate bypassed supply lines (see Figure 98); otherwise, the linear device supply rails can fluctuate due to voltage drops caused by high switching currents in the digital logic.
- Use proper bypass techniques to reduce the probability of noise-induced errors. Single capacitive decoupling is often adequate; however, RC decoupling may be necessary in high-frequency applications.



(a) COMMON-SUPPLY RAILS

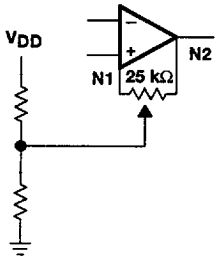


(b) SEPARATE-BYPASSED SUPPLY RAILS (preferred)

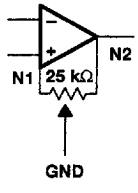
Figure 98. Common Versus Separate Supply Rails

input offset voltage nulling

The TLV2341 offers external input offset null control. Nulling of the input offset voltage can be achieved by adjusting a 25-kΩ potentiometer connected between the offset null terminals with the wiper connected as shown in Figure 99. The amount of nulling range varies with the bias selection. In the high-bias mode, the nulling range allows the maximum offset voltage specified to be trimmed to zero. In low-bias and medium-bias modes, total nulling may not be possible.



(a) SINGLE SUPPLY



(b) SPLIT SUPPLY

Figure 99. Input Offset Voltage Null Circuit

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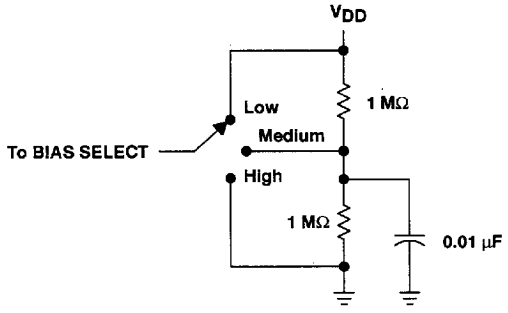
APPLICATION INFORMATION

bias selection

Bias selection is achieved by connecting the bias-select pin to one of the three voltage levels (see Figure 100). For medium-bias applications, it is recommended that the bias-select pin be connected to the midpoint between the supply rails. This is a simple procedure in split-supply applications, since this point is ground. In single-supply applications, the medium-bias mode necessitates using a voltage divider as indicated. The use of large-value resistors in the voltage divider reduces the current drain of the divider from the supply line. However, large-value resistors used in conjunction with a large-value capacitor require significant time to charge up to the supply midpoint after the supply is switched on. A voltage other than the midpoint may be used if it is within the voltages specified in the following table.



BIAS MODE	BIAS-SELECT VOLTAGE (single supply)
Low	V_{DD}
Medium	1 V to V_{DD} –1 V
High	GND

Figure 100. Bias Selection for Single-Supply Applications

input characteristics

The TLV2341 is specified with a minimum and a maximum input voltage that, if exceeded at either input, could cause the device to malfunction. Exceeding this specified range is a common problem, especially in single-supply operation. The lower the range limit includes the negative rail, while the upper range limit is specified at V_{DD} –1 V at T_A = 25°C and at V_{DD} –1.2 V at all other temperatures.

The use of the polysilicon-gate process and the careful input circuit design gives the TLV2341 good input offset voltage drift characteristics relative to conventional metal-gate processes. Offset voltage drift in CMOS devices is highly influenced by threshold voltage shifts caused by polarization of the phosphorus dopant implanted in the oxide. Placing the phosphorus dopant in a conductor (such as a polysilicon gate) alleviates the polarization problem, thus reducing threshold voltage shifts by more than an order of magnitude. The offset voltage drift with time has been calculated to be typically 0.1 µV/month, including the first month of operation.

Because of the extremely high input impedance and resulting low bias-current requirements, the TLV2341 is well suited for low-level signal processing; however, leakage currents on printed-circuit boards and sockets can easily exceed bias-current requirements and cause a degradation in device performance. It is good practice to include guard rings around inputs (similar to those of Figure 95 in the Parameter Measurement Information section). These guards should be driven from a low-impedance source at the same voltage level as the common-mode input (see Figure 101).

The inputs of any unused amplifiers should be tied to ground to avoid possible oscillation.

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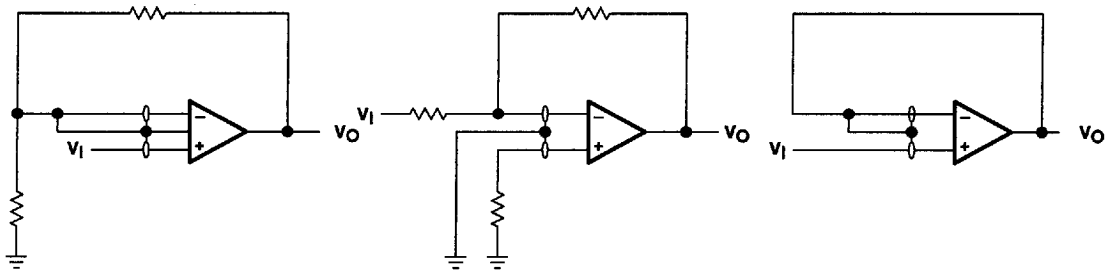
APPLICATION INFORMATION

input characteristics (continued)



(a) NONINVERTING AMPLIFIER (b) INVERTING AMPLIFIER (c) UNITY-GAIN AMPLIFIER

Figure 101. Guard-Ring Schemes

noise performance

The noise specifications in operational amplifiers circuits are greatly dependent on the current in the first-stage differential amplifier. The low input bias-current requirements of the TLV2341 results in a very low noise current, which is insignificant in most applications. This feature makes the device especially favorable over bipolar devices when using values of circuit impedance greater than 50 kΩ, since bipolar devices exhibit greater noise currents.

feedback

Operational amplifier circuits nearly always employ feedback, and since feedback is the first prerequisite for oscillation, caution is appropriate. Most oscillation problems result from driving capacitive loads and ignoring stray input capacitance. A small-value capacitor connected in parallel with the feedback resistor is an effective remedy (see Figure 102). The value of this capacitor is optimized empirically.

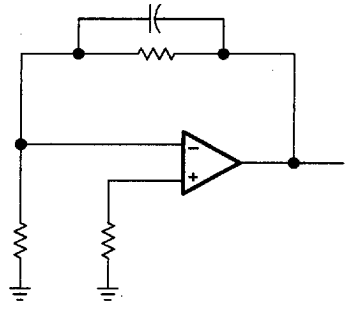


Figure 102. Compensation for Input Capacitance

electrostatic-discharge protection

The TLV2341 incorporates an internal electrostatic-discharge (ESD)-protection circuit that prevents functional failures at voltages up to 2000 V as tested under MIL-STD-883C, Method 3015.2. Care should be exercised, however, when handling these devices as exposure to ESD may result in the degradation of the device parametric performance. The protection circuit also causes the input bias currents to be temperature dependent and have the characteristics of a reverse-biased diode.

latch-up

Because CMOS devices are susceptible to latch-up due to their inherent parasitic thyristors, the TLV2341 inputs and output are designed to withstand –100-mA surge currents without sustaining latch-up; however, techniques should be used to reduce the chance of latch-up whenever possible. Internal protection diodes should not by

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design be forward biased. Applied input and output voltage should not exceed the supply voltage by more that 300 mV. Care should be exercised when using capacitive coupling on pulse generators. Supply transients should be shunted by the use of decoupling capacitors (0.1 μF typical) located across the supply rails as close to the device as possible.

The current path established if latch-up occurs is usually between the positive supply rail and ground and can be triggered by surges on the supply lines and/or voltages on either the output or inputs that exceed the supply voltage. Once latch-up occurs, the current flow is limited only by the impedance of the power supply and the forward resistance of the parasitic thyristor and usually results in the destruction of the device. The chance of latch-up occurring increases with increasing temperature and supply voltages.

output characteristics

The output stage of the TLV2341 is designed to sink and source relatively high amounts of current (see Typical Characteristics). If the output is subjected to a short-circuit condition, this high-current capability can cause device damage under certain conditions. Output current capability increases with supply voltage.

Although the TLV2341 possesses excellent high-level output voltage and current capability, methods are available for boosting this capability if needed. The simplest method involves the use of a pullup resistor (R_P) connected from the output to the positive supply rail (see Figure 103). There are two disadvantages to the use of this circuit. First, the NMOS pulldown transistor N4 (see equivalent schematic) must sink a comparatively large amount of current. In this circuit, N4 behaves like a linear resistor with an on resistance between approximately 60 Ω and 180 Ω, depending on how hard the operational amplifier input is driven. With very low values of R_P, a voltage offset from 0 V at the output occurs. Secondly, pullup resistor R_P acts as a drain load to N4 and the gain of the operational amplifier is reduced at output voltage levels where N5 is not supplying the output current.

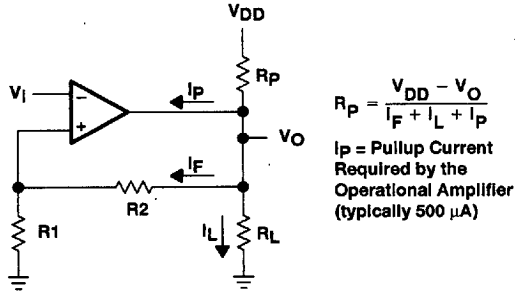

Figure 103. Resistive Pullup to Increase V_{OH}

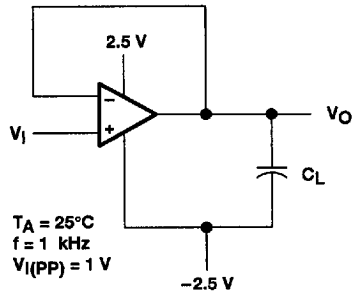

Figure 104. Test Circuit for Output Characteristics

All operating characteristics of the TLV2341 are measured using a 20-pF load. The device drives higher capacitive loads; however, as output load capacitance increases, the resulting response pole occurs at lower frequencies thereby causing ringing, peaking, or even oscillation (see Figures 105, 106 and 107). In many cases, adding some compensation in the form of a series resistor in the feedback loop alleviates the problem.

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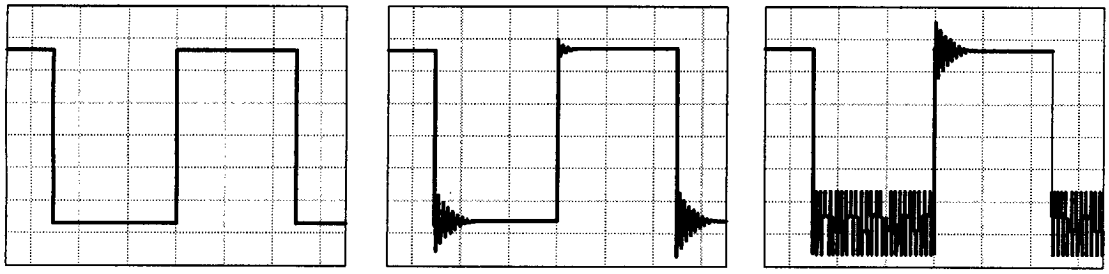
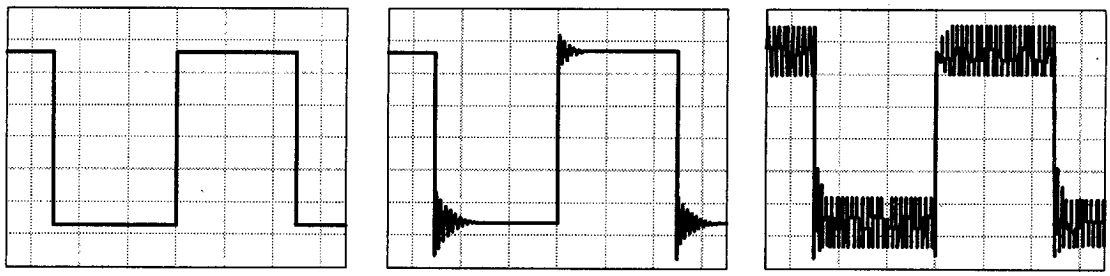
output characteristics (continued)



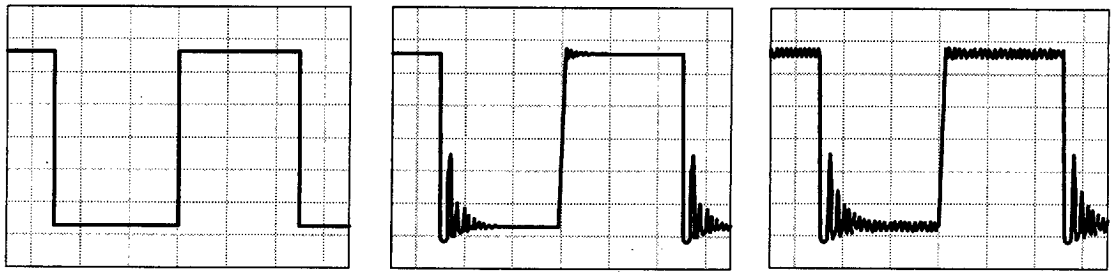
(a) C_L = 20 pF, R_L = NO LOAD (b) C_L = 130 pF, R_L = NO LOAD (c) C_L = 150 pF, R_L = NO LOAD

Figure 105. Effect of Capacitive Loads in High-Bias Mode



(a) C_L = 20 pF, R_L = NO LOAD (b) C_L = 170 pF, R_L = NO LOAD (c) C_L = 190 pF, R_L = NO LOAD

Figure 106. Effect of Capacitive Loads in Medium-Bias Mode



(a) C_L = 20 pF, R_L = NO LOAD (b) C_L = 260 pF, R_L = NO LOAD (c) C_L = 310 pF, R_L = NO LOAD

Figure 107. Effect of Capacitive Loads in Low-Bias Mode

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